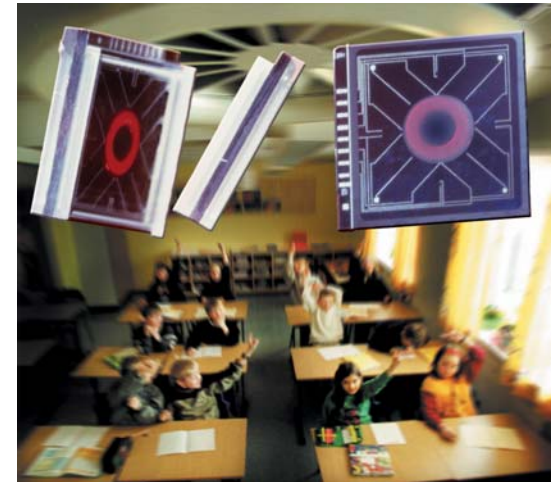
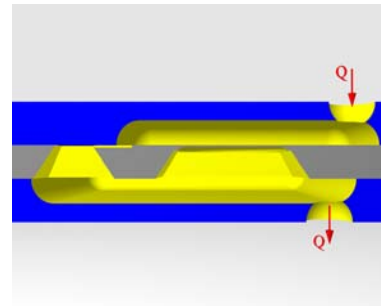


Fys4230

Mikro- og nanosystem modellering og design

10 studiepoeng høsten 2006

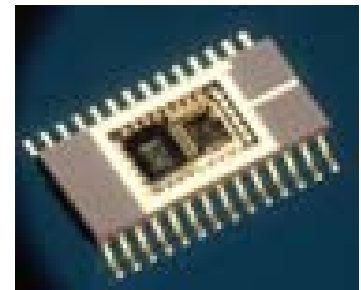
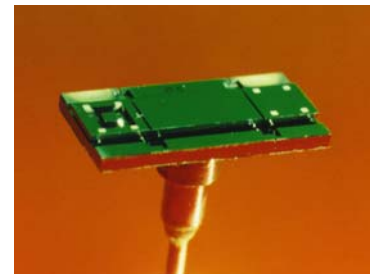
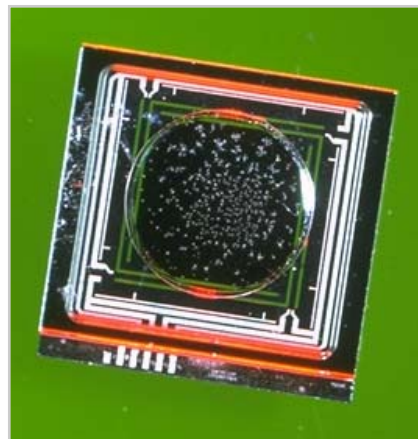
Foreleser Liv Furuberg
Seniorforsker
SINTEF Informasjon og
kommunikasjonsteknologi



GlucoWatch® Biographer



AutoSensor

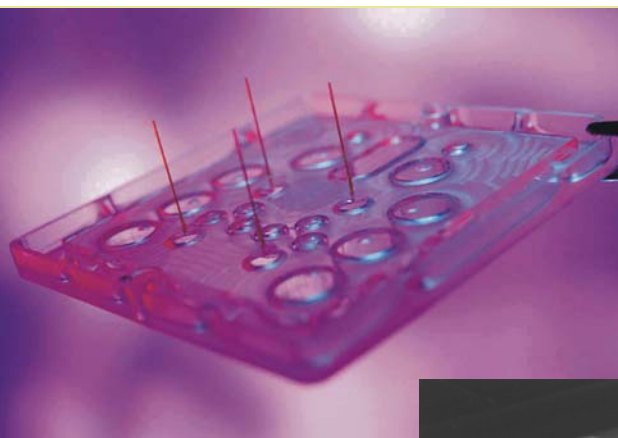


web page with all course information

- <http://www.uio.no/studier/emner/matnat/fys/FYS4230/h06/>
- Messages, keep yourself updated!
 - Example: next week lecture will take place in MiNaLab, Gaustadbekkdalen
- Powerpoint presentations from lectures
- Exercises
- 3 compulsory exercises, deadlines

Course contents, 4 main “cases”:

- 1) Micro fabrication
- 2) Design of lithographic masks
- 3) Physics governing behaviour of microsystems
- 4) Modelling of behaviour of microsystems

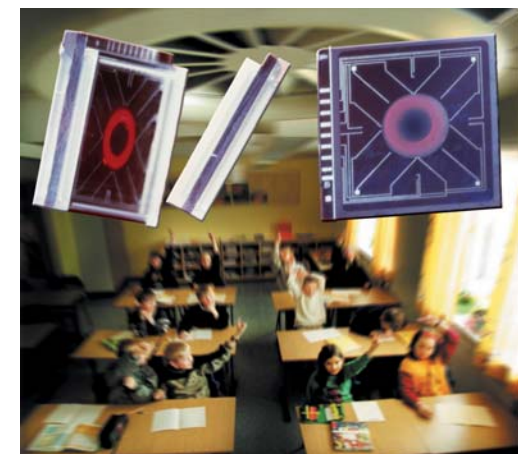


Lab-on-a-chip

Accelerometer

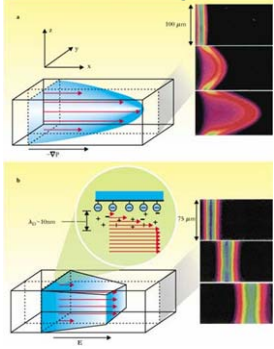


Projector

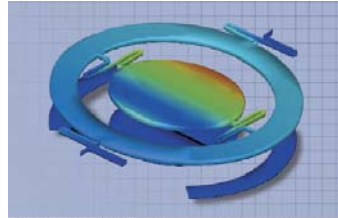


Pressure sensor

Fluid dynamics

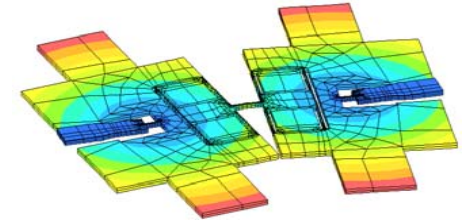


Multiphysics



Analysis of a MEMS mirror illustrates the relative displacement of its components. You can also choose modal frequency, residual stress, maximum stress, electrostatic force of electrodes, beam attraction, and crosstalk between multiple mirrors in an array.

Structural mechanics



Electronics

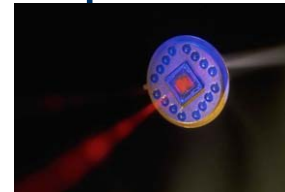
Signal processing

Chemistry

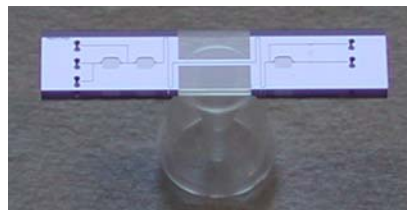
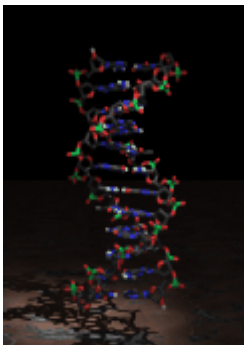
Challenge:

Design functional elements that can be manufactured by microtechnology

Optics



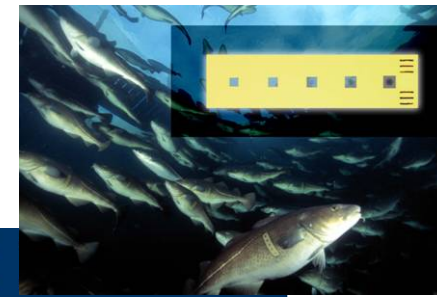
Biotechnology



Capillary flow
Surface physics

Functional thin films

Material science



MiNaLab i Oslo

- Mikro- og Nanoteknologilaboratoriet I Gaustadbekkdalen
- MiNaLab

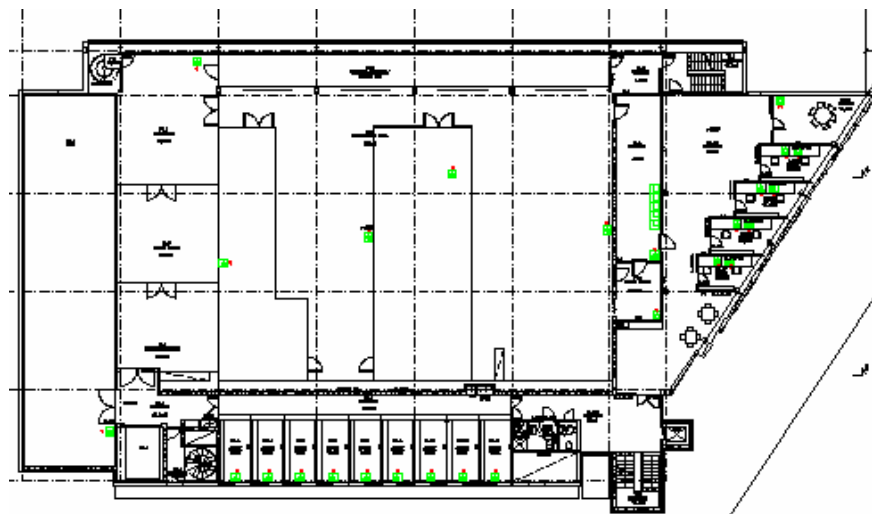
- Mikrosystemer =
TVERRFAGLIGHET!



MiNaLab

SINTEF:

- Renromsareal: 800 m²
- Microenvironments med klasse 10
- Ballroom: klasse 1000
- Produksjonslinje med årlig kapasitet opp til 8000 silisiumskiver



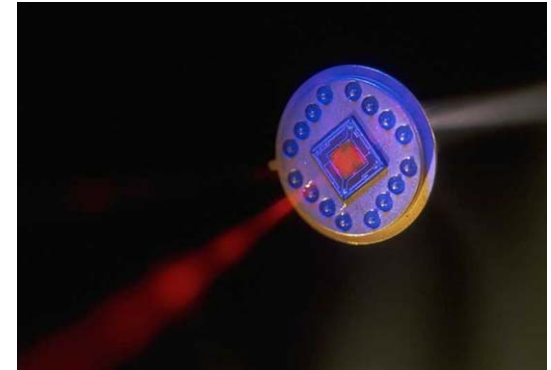
Universitetet i Oslo:

- Renromsareal 400 m²
- Utstyr: NFR
- Bygget: SINTEF + NFR



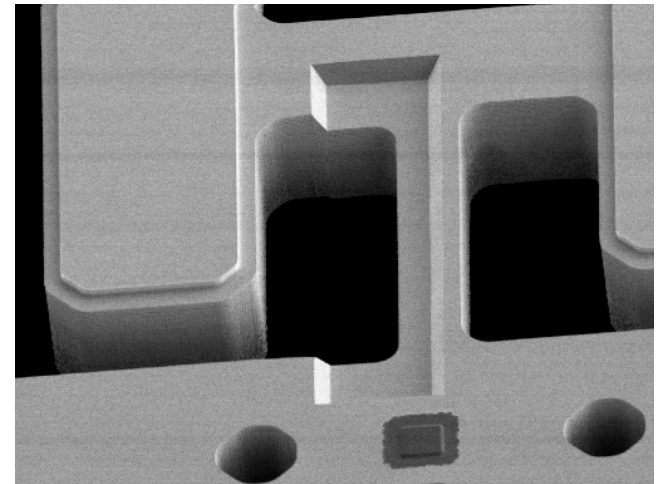
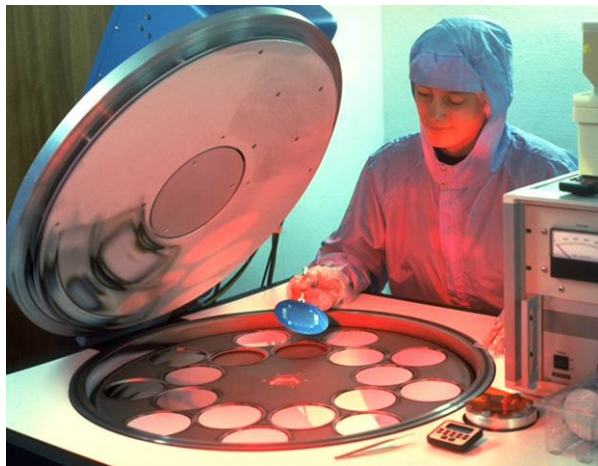
- **MEMS (Micro-Electro-Mechanical Systems)**
- **Microsystems**
- **Microtechnology**

- Sensors and actuators
- The functional element is of micrometer scale
- Made from silicon, quartz or polymer
- Integrated with electronic circuits
- Produced using integrated circuit fabrication technologies

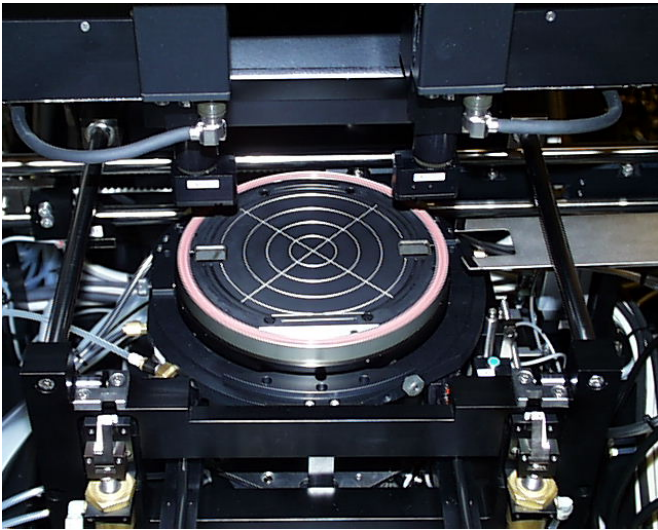


Micromachining

- Top – down manufacturing
- 3D structures
- Lithography defines areas to be etched away
- Bonding of several wafers
- Thin films



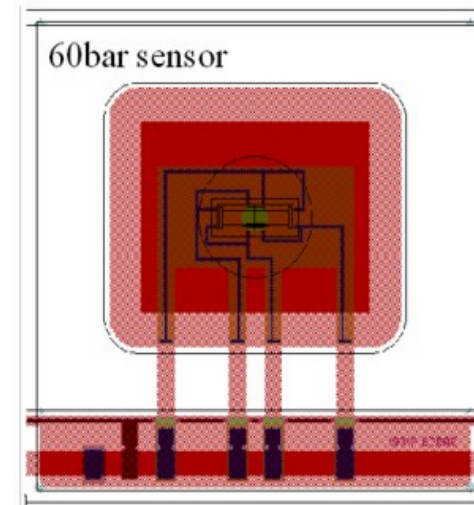
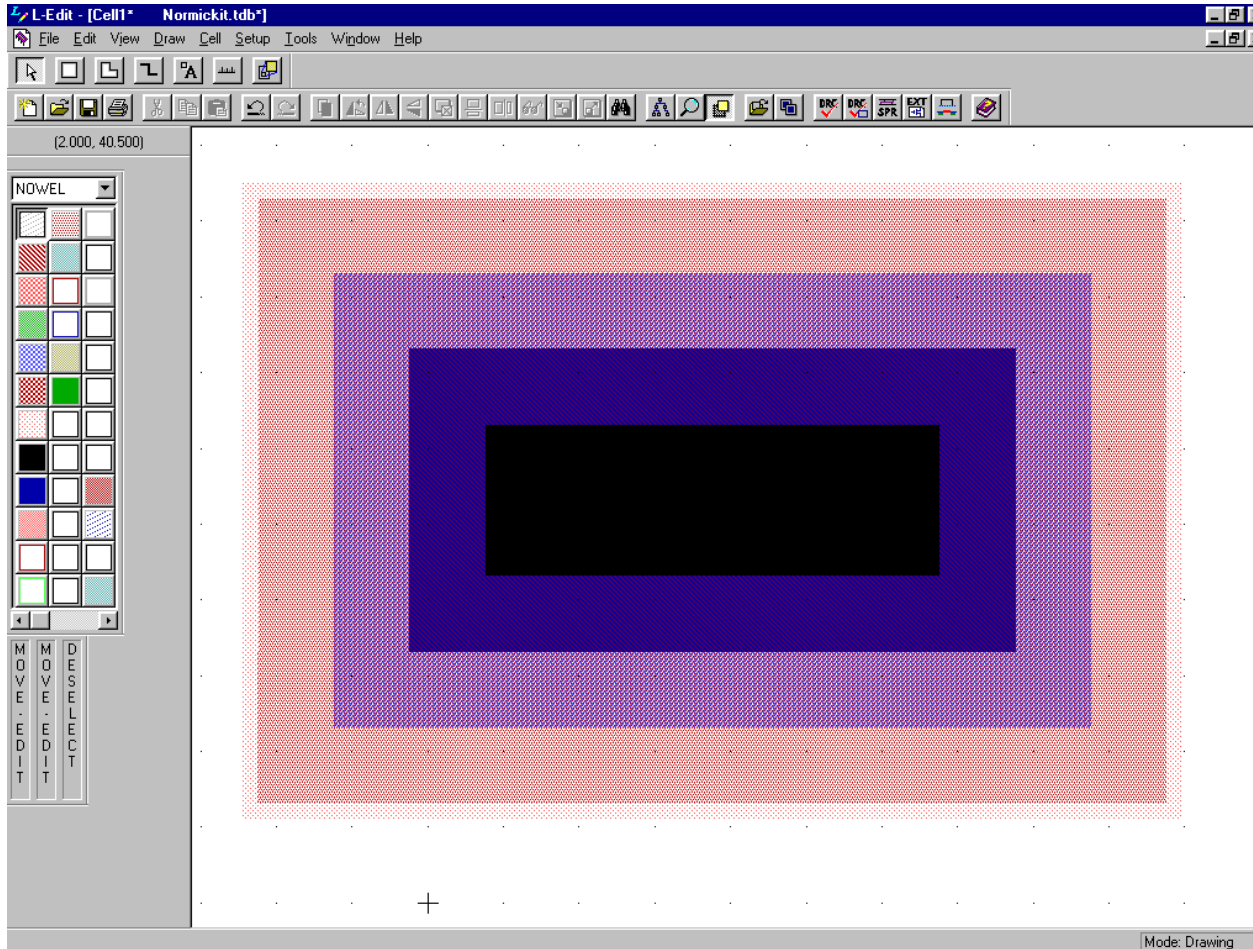
Micromachining equipment, SINTEF



- Photolithography
- Furnaces for diffusion and oxidation
- ICP PECVD (deposition)
- Deep reactive ion etch
- Wet etch of silicon
- “Quick and dirty room”
- Silicon/glass wafer bonding
- Dicing
- Measurement lab + SEM

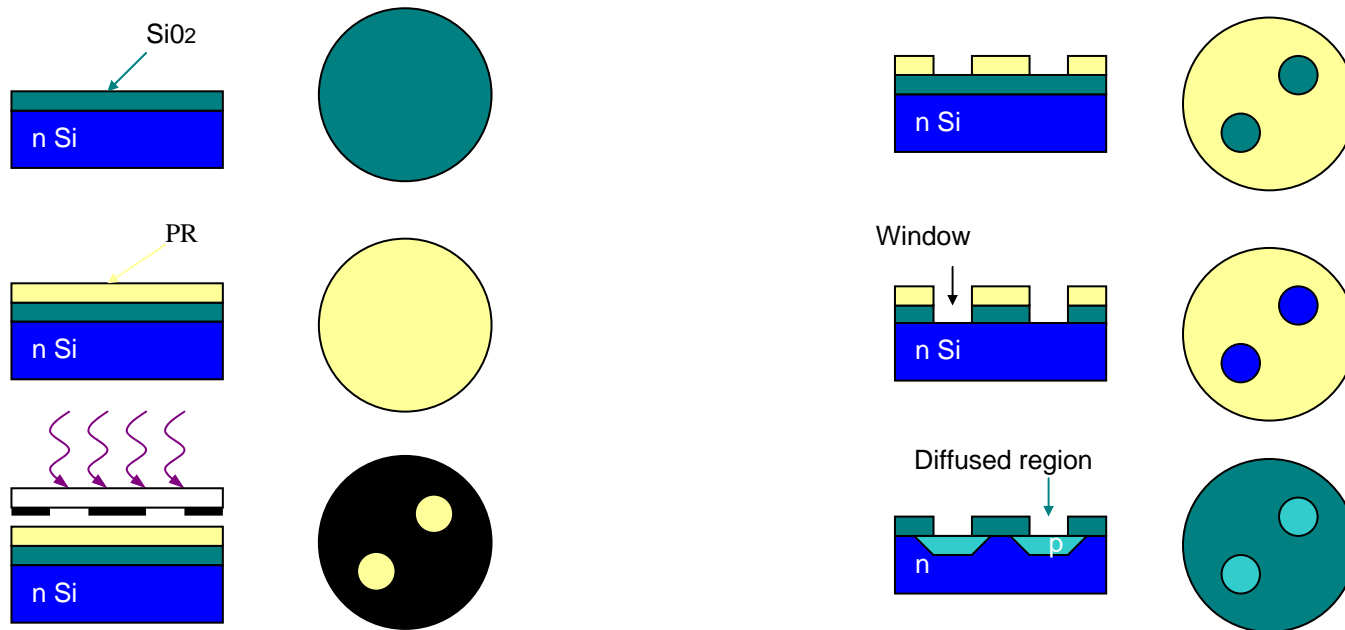


Layout of lithographic masks



Fotolitografi

Mønsteroverføring fra maske til resistfilm på silisiumskive

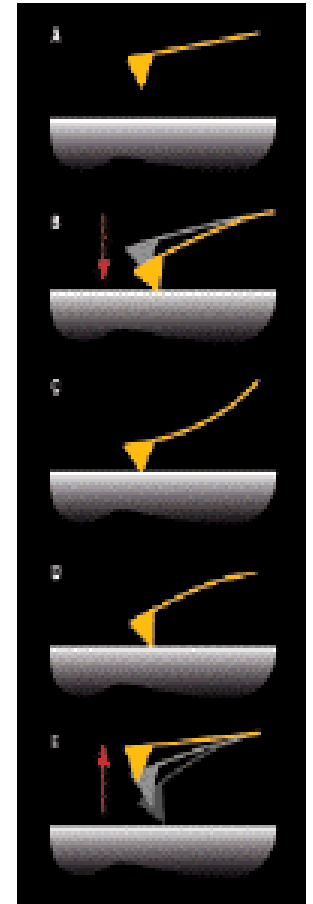
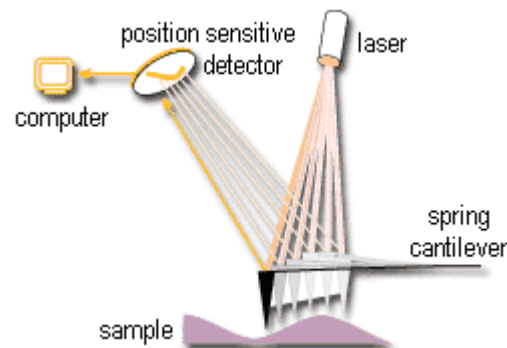
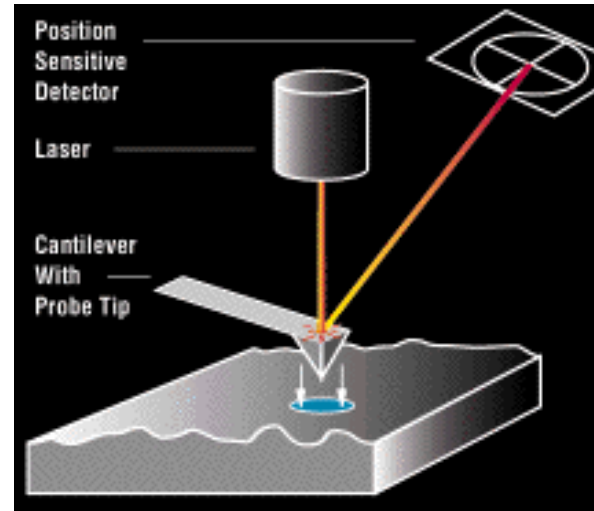


Beam example: Atomic Force Microscope

- Measures force between tip of cantilever and object
- E.g. forces from surface, weight of molecule
- Size of cantilever:
 - 100-500 μm long
 - 0.5-5 μm thick

• How to measure forces?

- Deflection of beam due to force can be measured by reflection of light
- Mechanical stress in beam is related to force and deflection and can be measured with piezoresistors



Translating biomolecular recognition into nanomechanics

Science 288, 2000

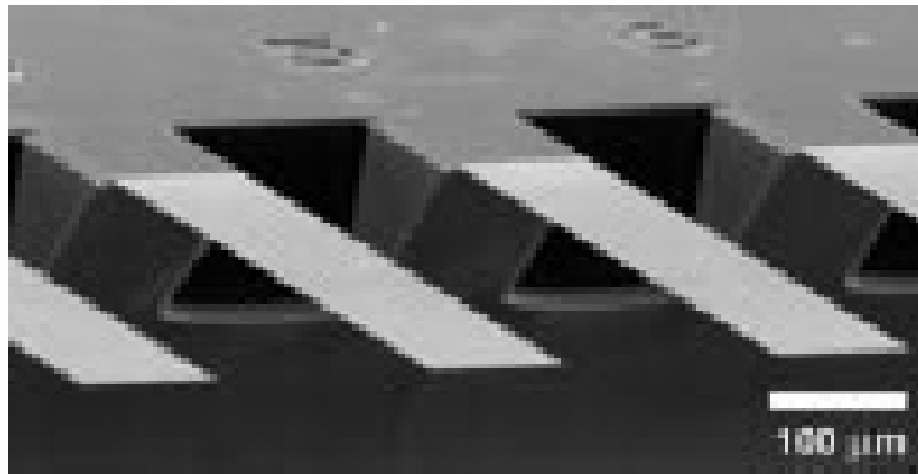


Fig. 1. Scanning electron micrograph of a section of a microfabricated silicon cantilever array (eight cantilevers, each 1 μm thick, 500 μm long, and 100 μm wide, with a pitch of 250 μm , spring constant 0.02 N m^{-1} ; Micro- and Nanomechanics Group, IBM Zurich Research Laboratory, Switzerland).

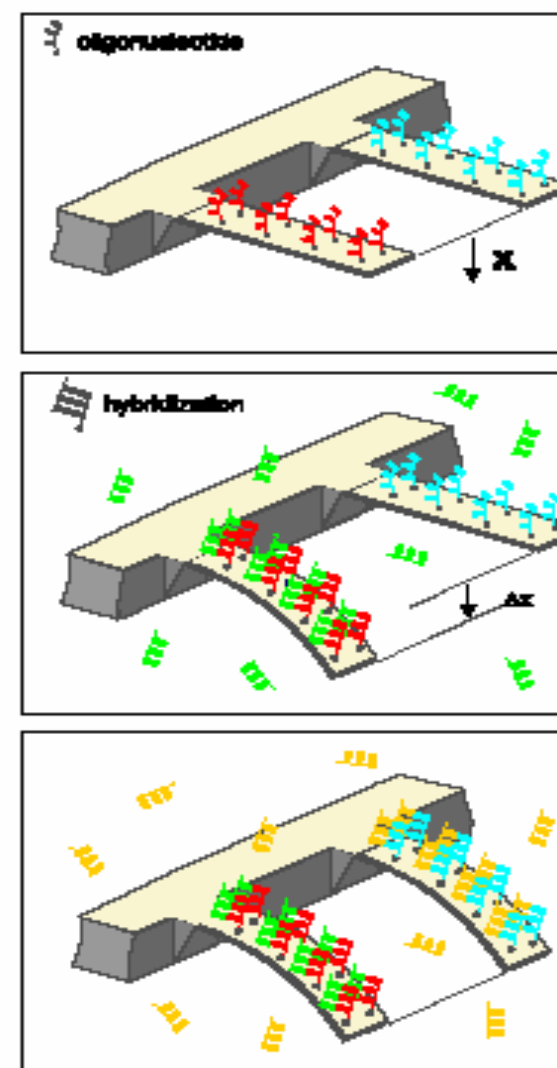


Fig. 2. Scheme illustrating the hybridization experiment. Each cantilever is functionalized one side with a different oligonucleotide sequence (red or blue). (A) The differential signal is set to zero. (B) After injection of first complementary oligonucleotide (green) hybridization occurs on the cantilever that provides the matching sequence (red), increasing the differential signal Δx . (C) Injection of second complementary oligonucleotide (yellow) causes the cantilever functionalized with the first oligonucleotide (red) to bend, and the second oligonucleotide (blue) to bend.

Bulk silicon micromachining

Millipede, IBM Zurich

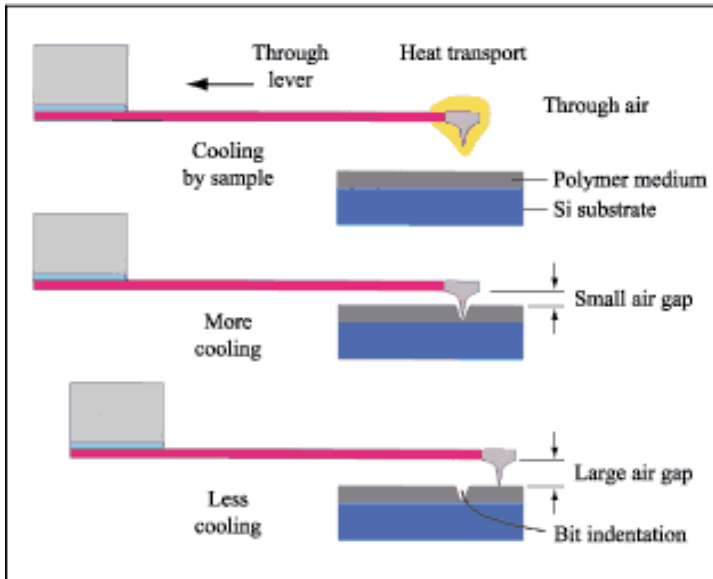
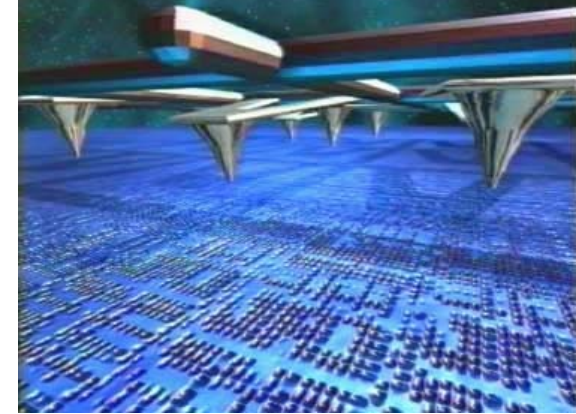


Figure 4

Principle of AFM thermal sensing. The heater cantilever is continuously heated by a dc power supply while it is being scanned and the heater resistivity measured. Adapted from [17(a)], with permission; © 1999 IEEE.

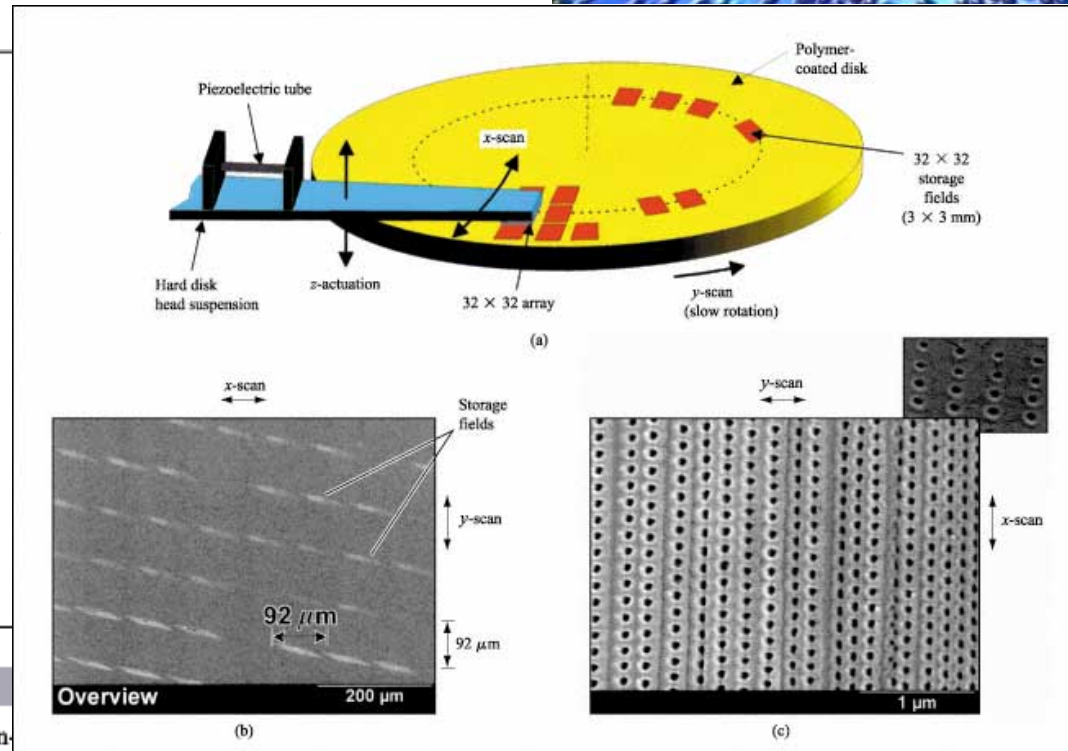


Figure 14

(a) Modified hard disk Millipede approach for array-chip scanning and displacement, and writing results; (b) SEM image of many storage fields; (c) magnified bit indentations in 100-nm-thick PMMA medium, equivalent to a storage density of 70–100 Gb/in.² Note that the x/y scan directions are interchanged between (b) and (c).

Capasitive surface comb-accelerometer

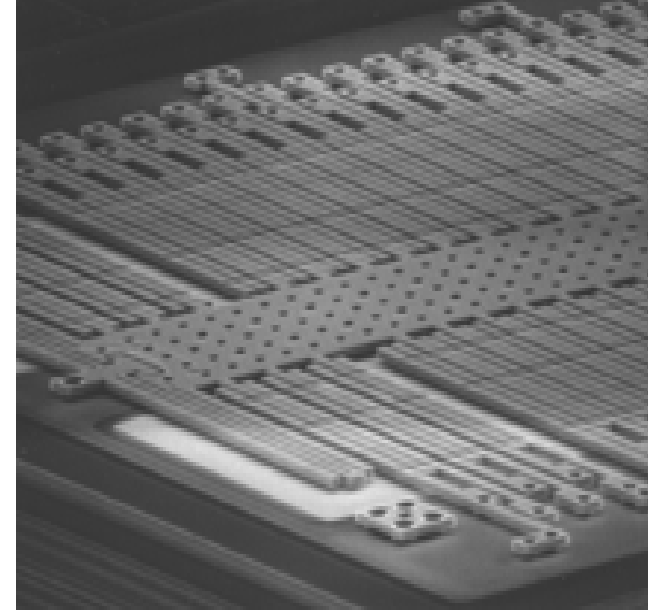
- Polysilicon
- Surface micromachining
- Cronos: PolyMUMPs (multi-project-wafer process)

Design of:

- Low-g accelerometer (5g)
- Capacitive read-out: collaboration with microelectronics

Self-test

Analog
Devices



Deposit sacrificial layer



Pattern contacts



Deposit/pattern structural layer



Etch sacrificial layer



A Capacitive Accelerometer

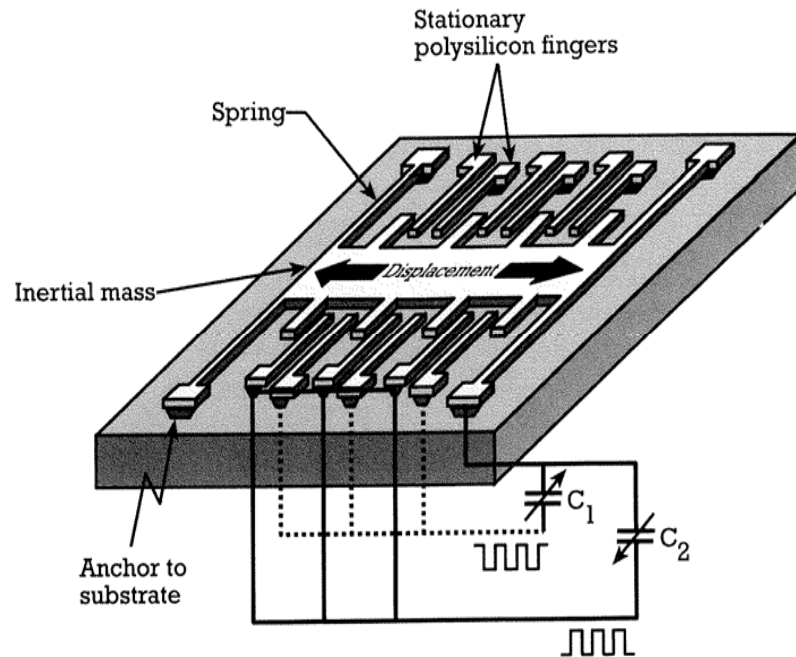
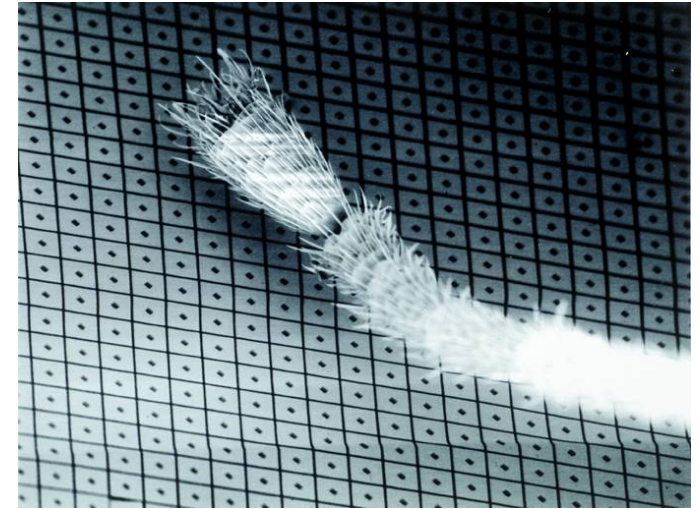


Image projector with micromachined mirrors Digital Light Processing, Texas Instruments

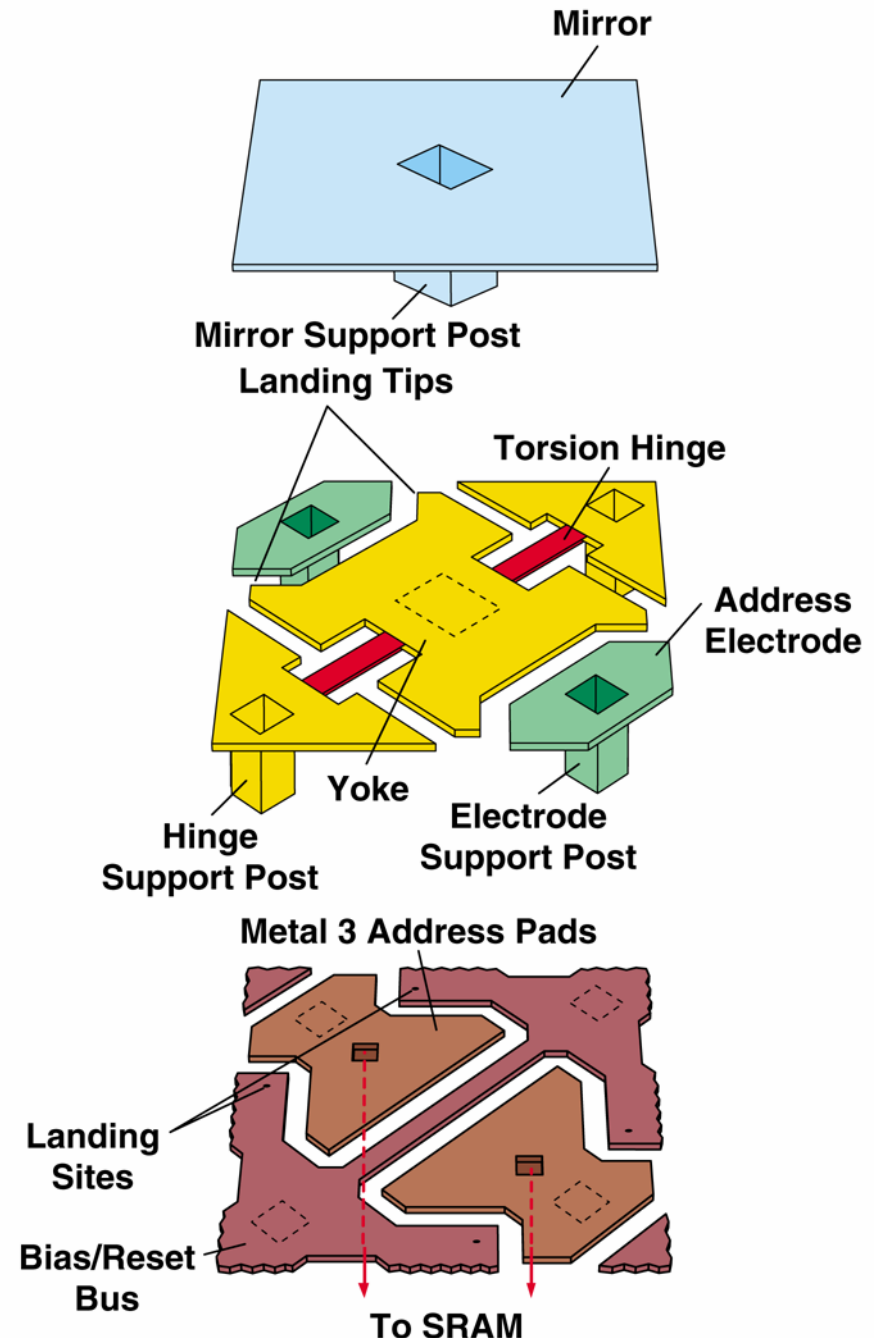


- Aluminium micromirrors fabricated on the surface of a silicon wafer with an integrated circuit
- Mirrors are individually controlled
- Size of mirror: $16\mu\text{m} \times 16\mu\text{m}$
- Mirrors separated by $1\mu\text{m}$
- One chip: 1280×1024 mirrors (1 310 720 mirrors)



One micromirror

- Actuated by electrostatic forces: apply a potential difference between mirror and electrode
- Elastic torsion forces oppose the tilt



Electro-Mechanical behaviour

- Coupled electro-mechanical problem

Governing equations

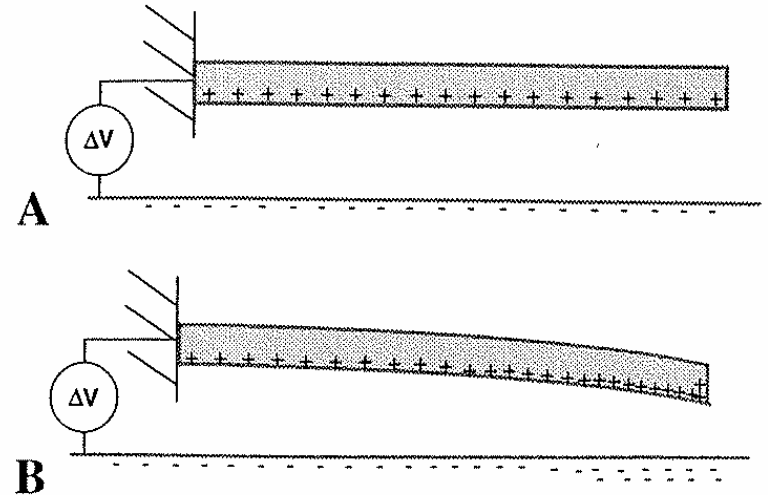
- Electrostatic potential between electrodes solving the Laplace equation
- Elasticity equation solved inside the beam

Solve

- Solve fully coupled systems of partial differential equations
- Alternately solve equations until equilibrium is reached

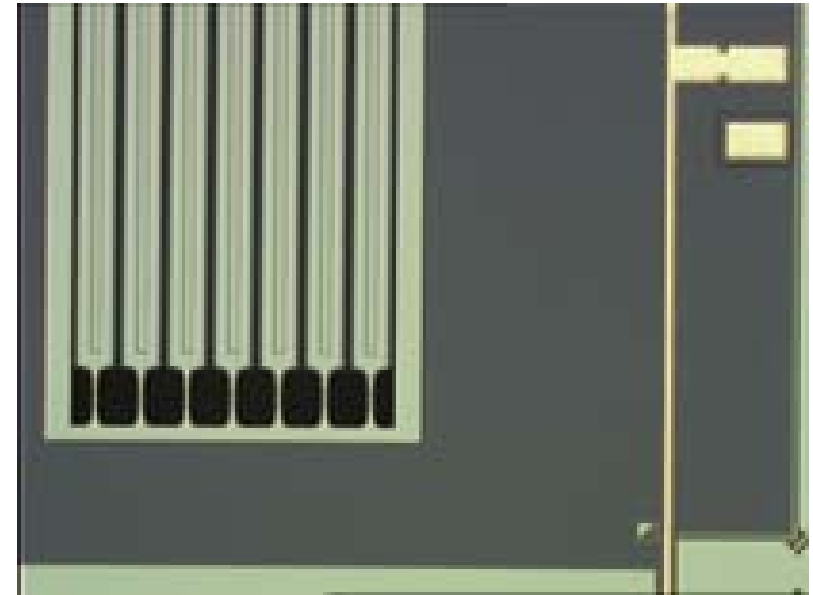
Surrounding fluid/gas

- Reynolds equation solved separately
- Viscous damping, film spring effect



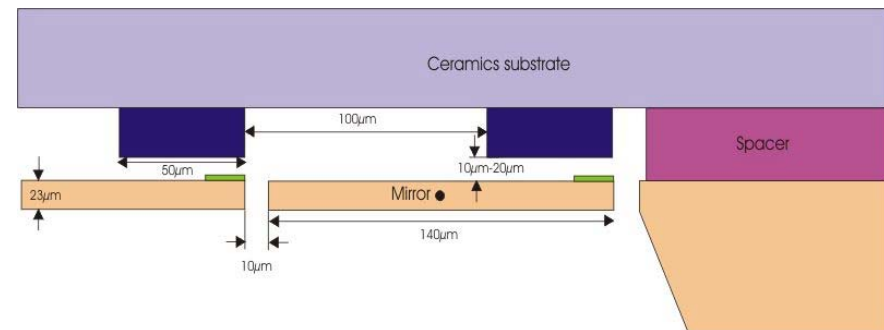
Bulk-micromachined mirror

- Application: bar-code reader
 - Electrostatic actuation
 - Mirrors tilts
 - Packaging: Tick film on ceramics (Microcomponent)
-
- Modelling: Multiphysics
 - Elasticity
 - Elektrostatics
 - Fluidics

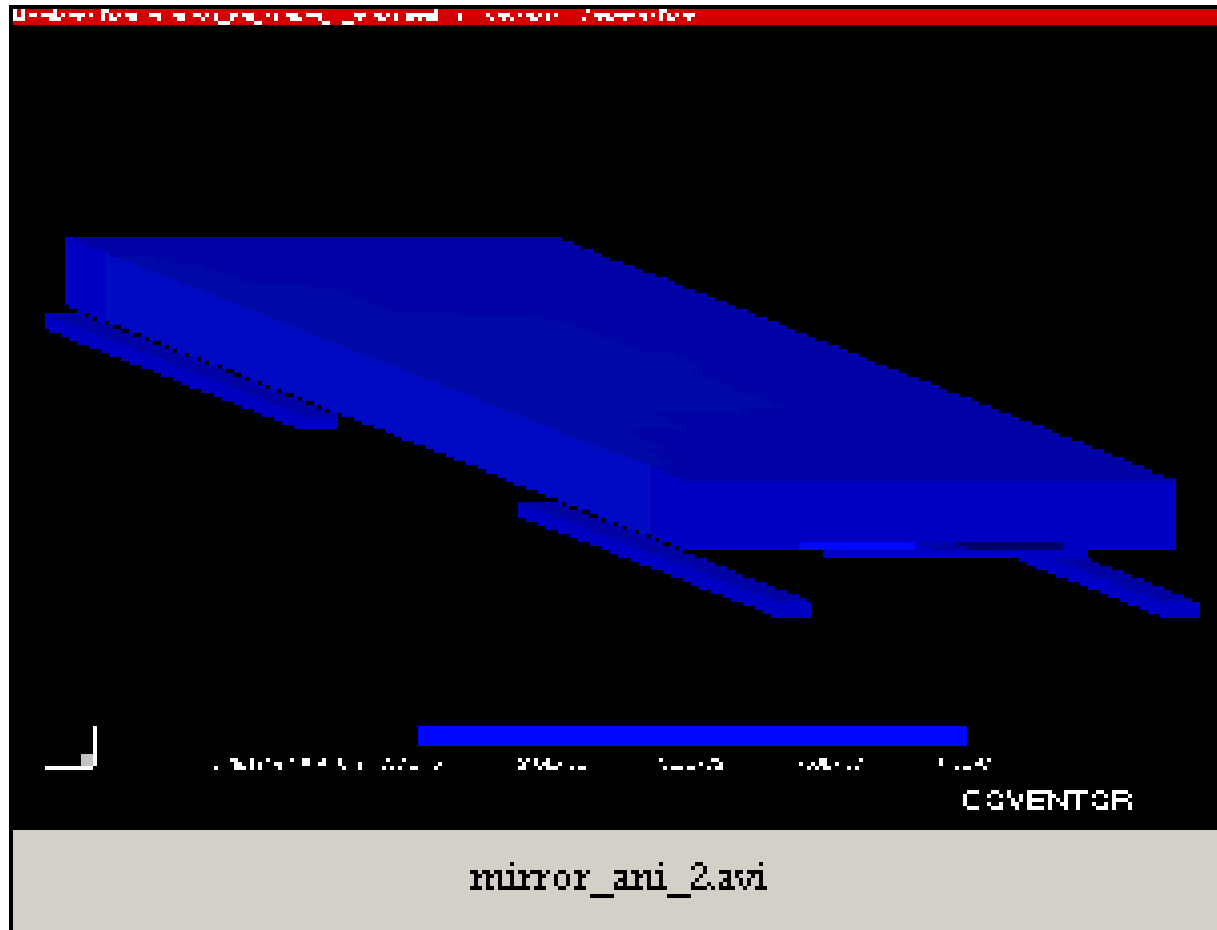


Parallel plate condensator \approx

$$F = -\frac{A\epsilon\epsilon_0}{2x^2}V^2$$



Coupled electrostatic-elastic simulation of mirror



Klaus Magnus Johansen, Oddvar Søråsen, Liv Furuberg, UiO

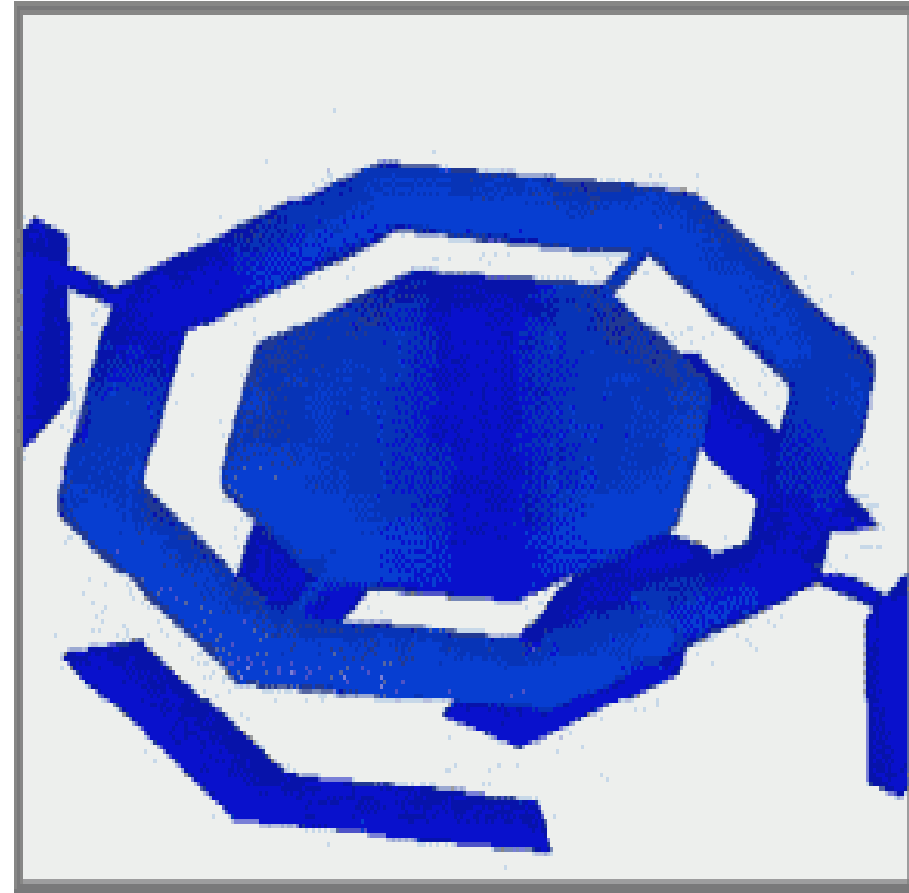
Mechanical and electrostatic equations

- Naviers equation for elastic forces: (isotropic version)

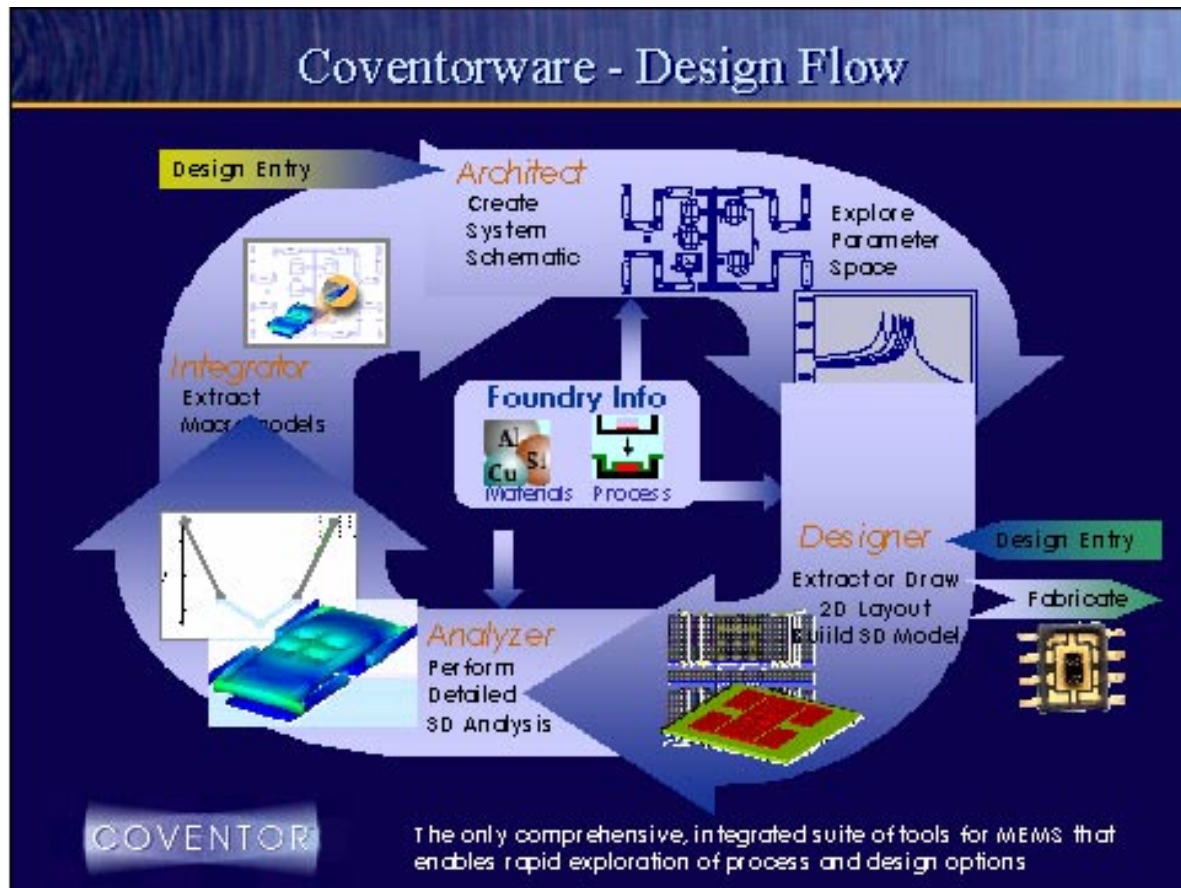
$$(\lambda + \mu)\nabla\nabla \cdot u + \mu\nabla^2 u = 0$$

- Poisson equation for electrostatic field:

$$\nabla^2 \Phi = -\frac{\rho}{\varepsilon}$$



Coventorware - Design Flow



Detailed modelling levels

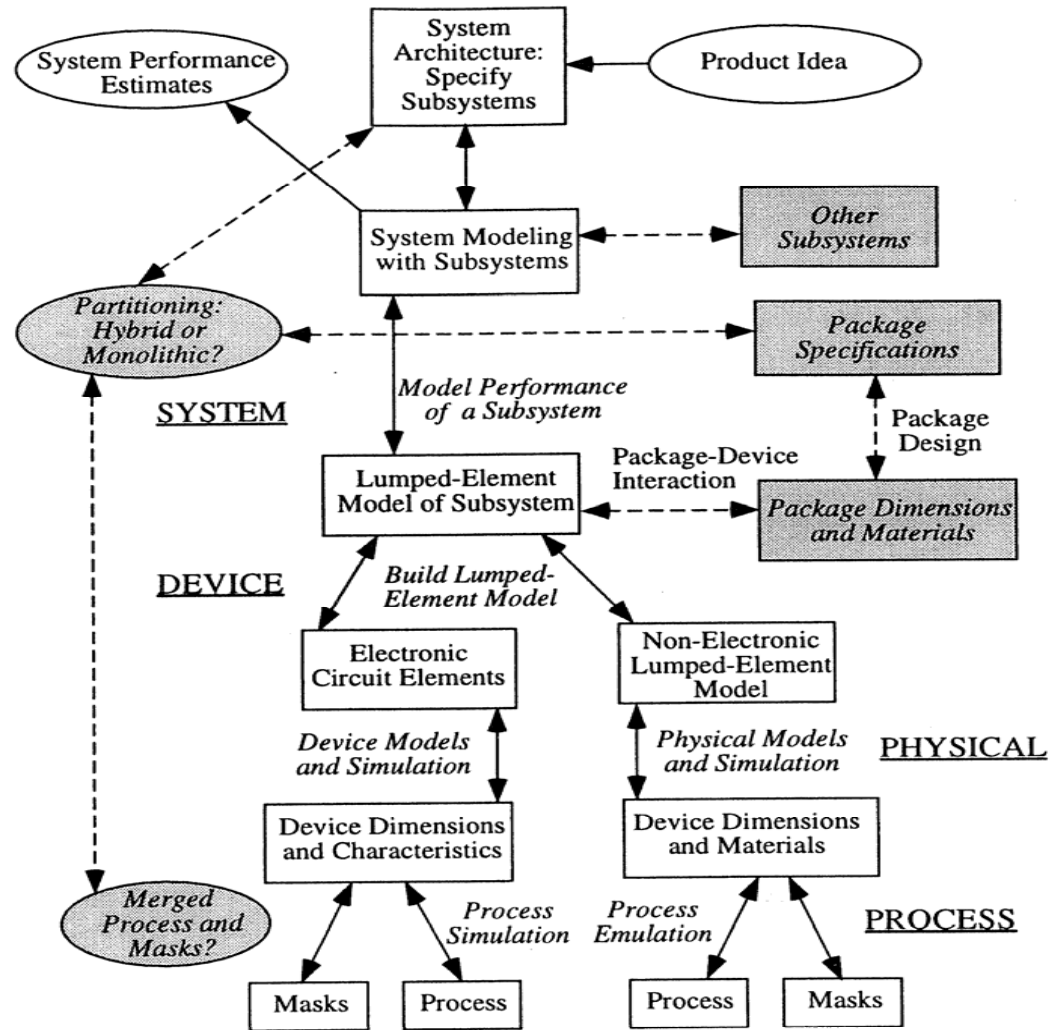
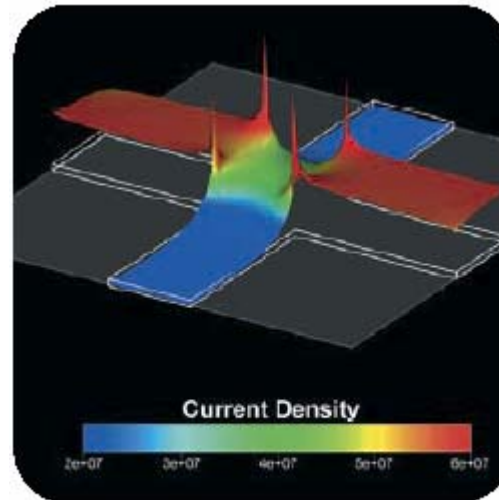
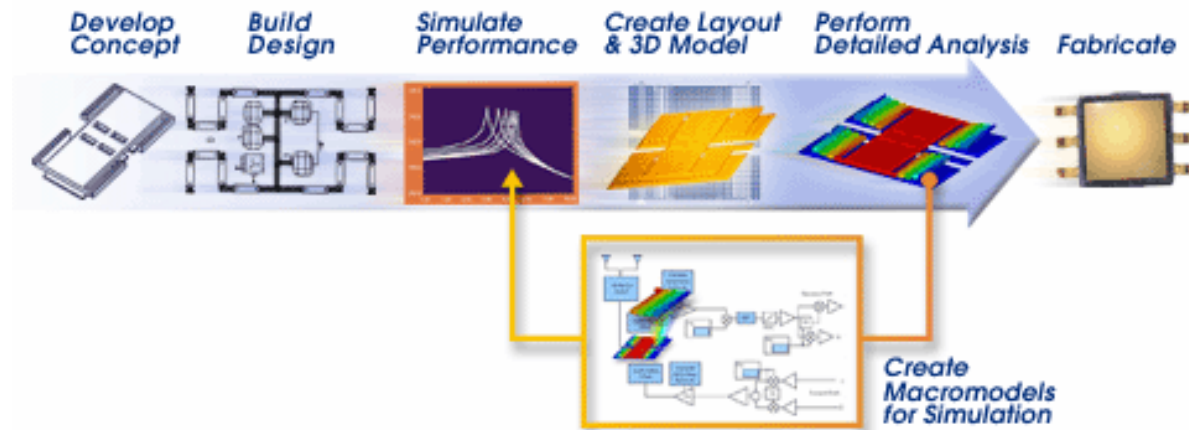


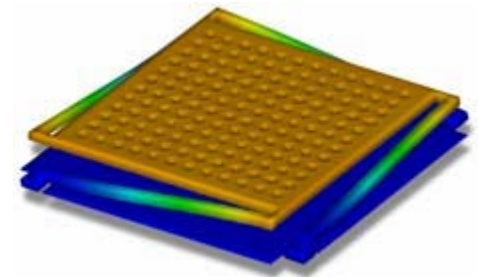
Figure 2.3. An expanded view of the “Modeling and Analysis” block of Fig. 2.1. The various modeling levels of Fig. 2.2 are indicated, and correspond to the entries in italics between the unshaded blocks. The shaded blocks are additional aspects of the design process not captured in Fig. 2.2.

Coventorware ANALYZER

- Device modelling
- Continuum mechanics
- Electromagnetism
- Optics
- Piezoelectricity
- Piezoresistivity
- Fluidics



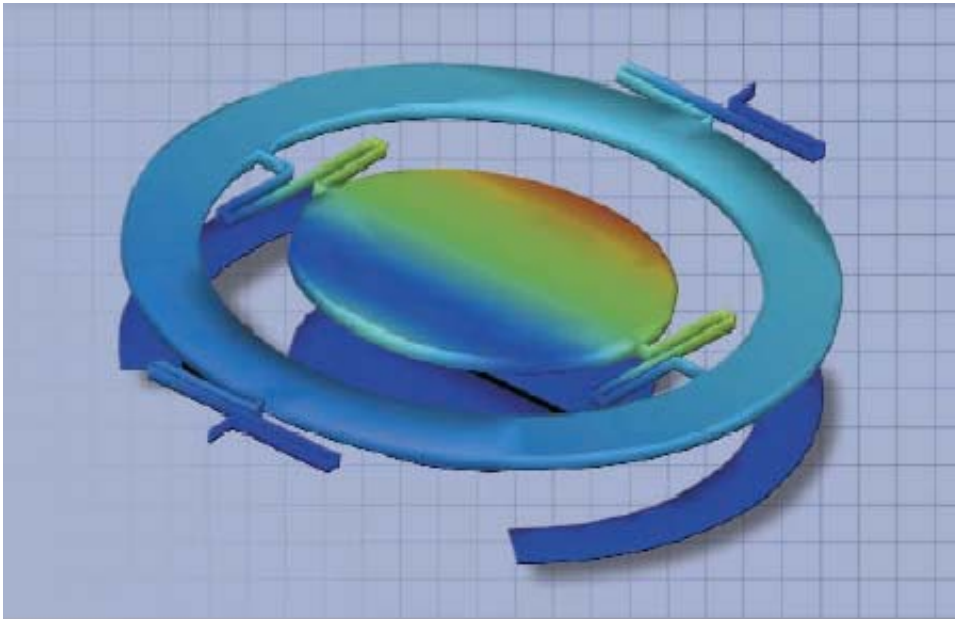
MemPZR analysis of a piezo-resistor cross



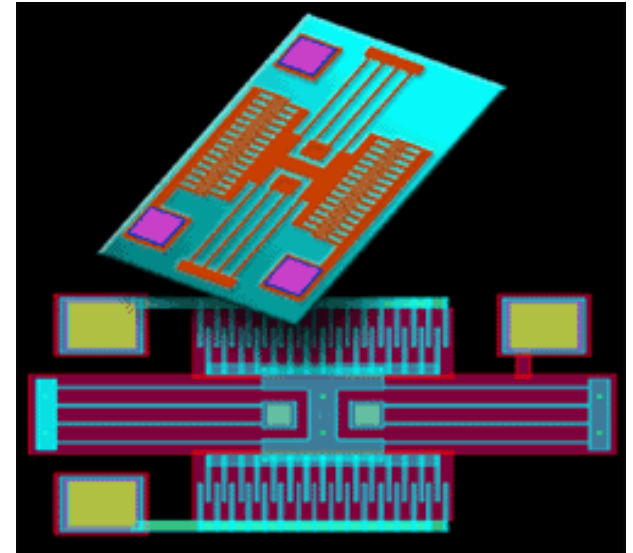
Coventorware

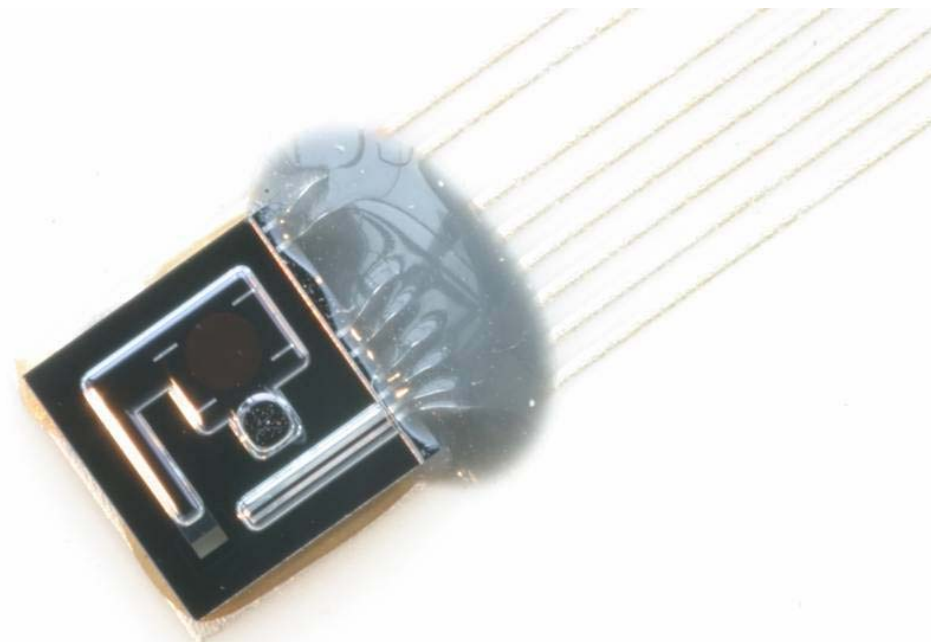
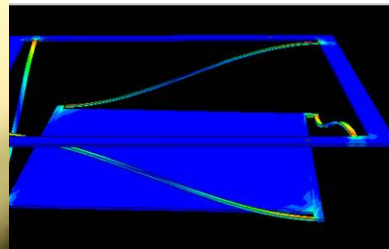
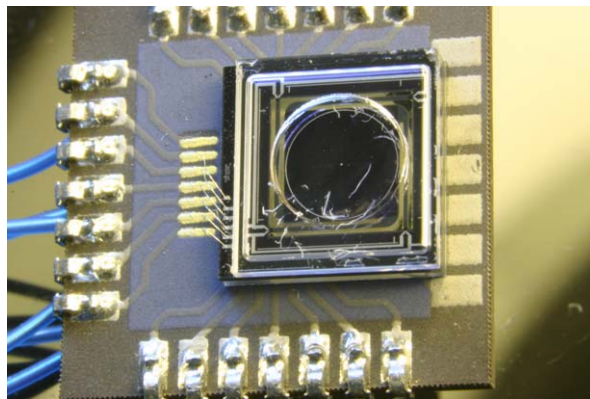
Microsystem modelling and layout

- Process generation
- Mask layout
- Device modelling

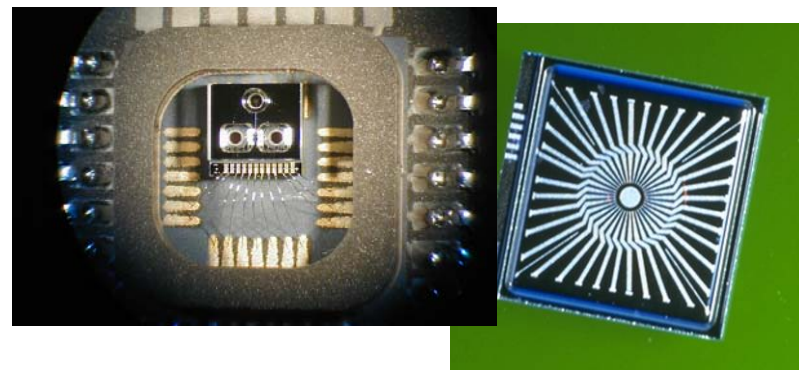
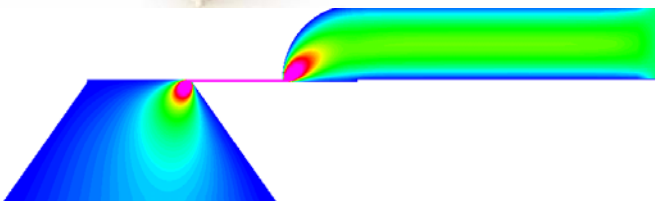


Analysis of a MEMS mirror illustrates the relative displacement of its components. You can also analyze modal frequency, residual stress, maximum stress, electrostatic force of electrodes, beam diffraction, and crosstalk between multiple mirrors in an array.

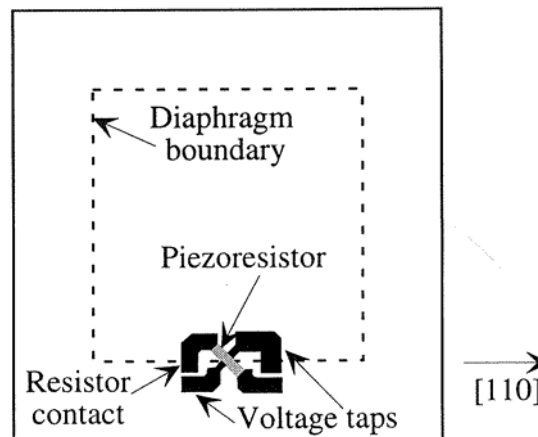
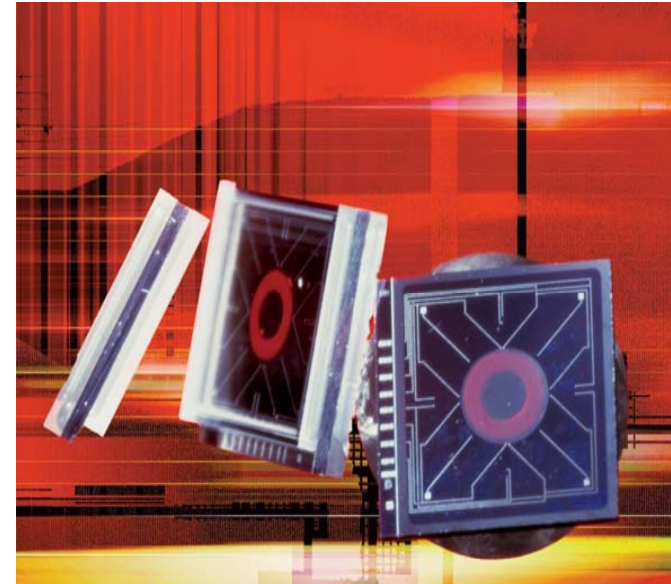
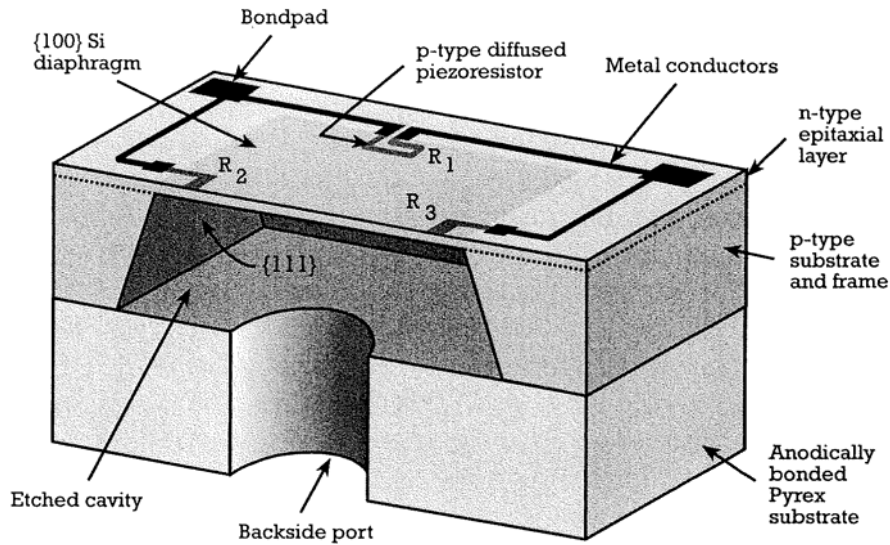




microBUILDER



Piezoresistive pressure sensors

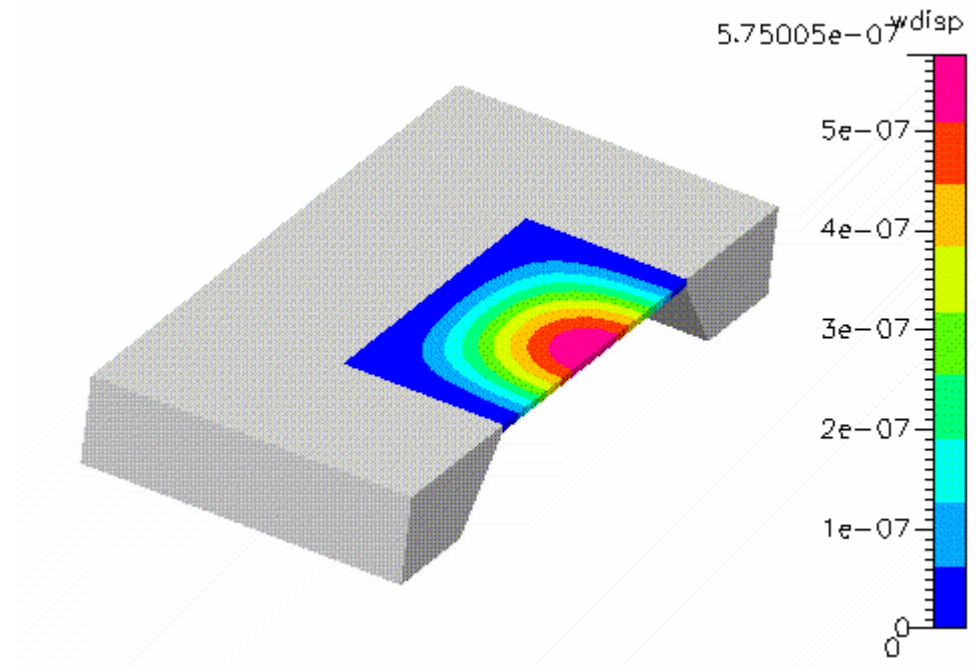


Mechanical modelling

- Deflection of mechanical elements due to forces
- Stress in mechanical elements
- 3D elasticity equation, plate or beam equations
- Crystal silicon

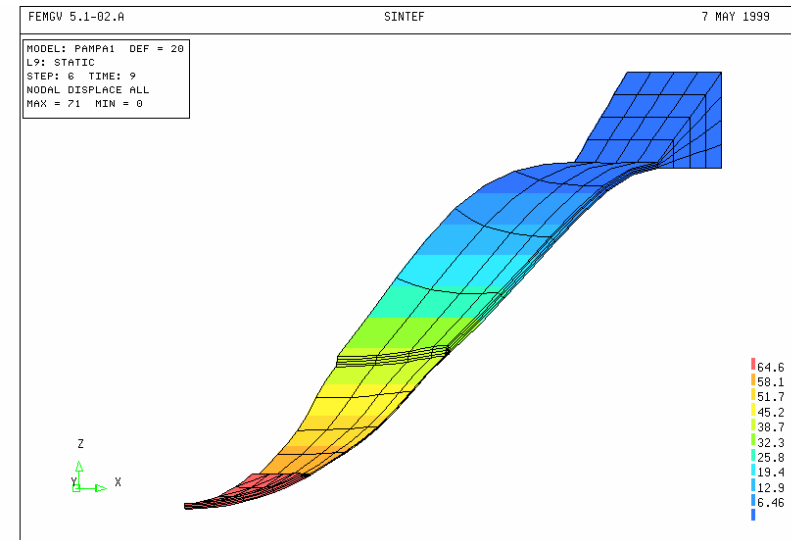
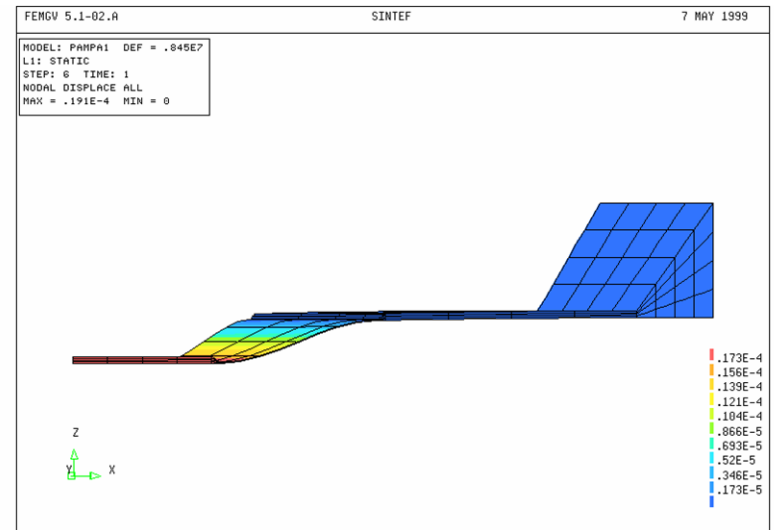
Membrane etched in single crystal silicon:

- $E=1.698 \times 10^{11} \text{ N/m}^2$,
 $\nu=0.066$
- Analytical solution
 $W_{\max}=5.732 \times 10^{-7} \text{ m}$
- Present prediction
 $W_{\max}=5.750 \times 10^{-7} \text{ m}$



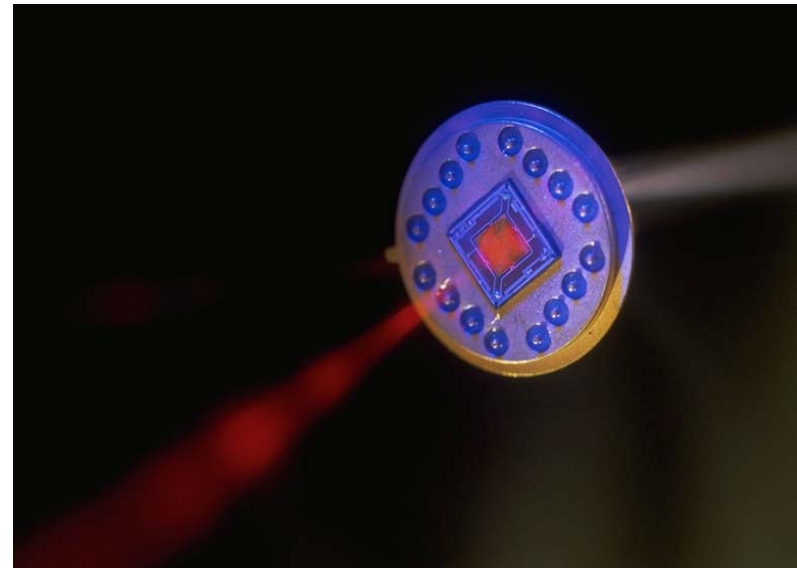
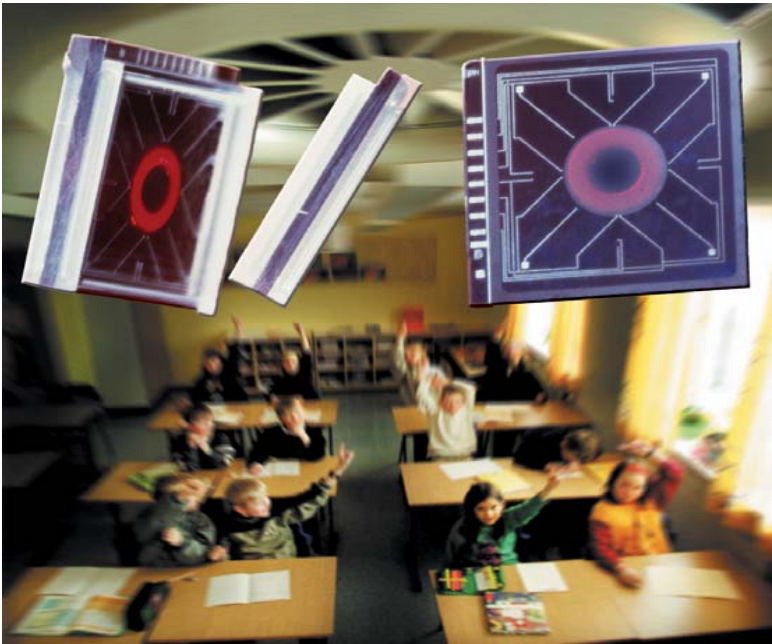
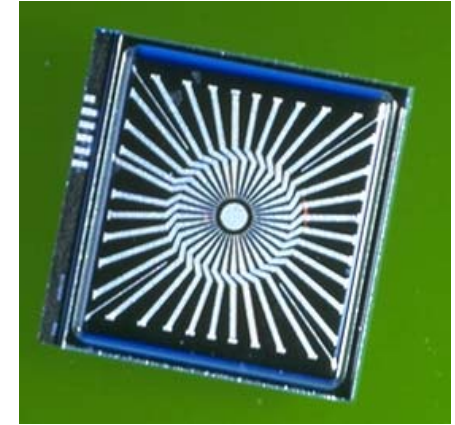
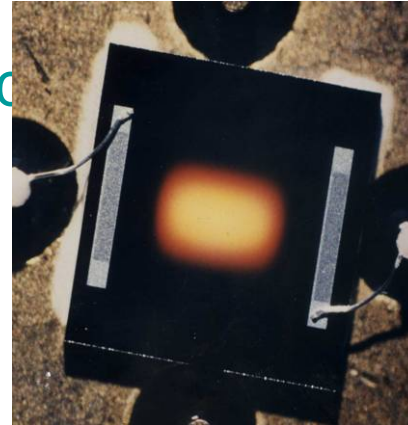
From compression to tension

- Turn membrane upside down
- Small pressures, thin membrane bends down, compression on lower side close to edges
- Large pressures, thick membrane bends down, thin membrane in state of tension



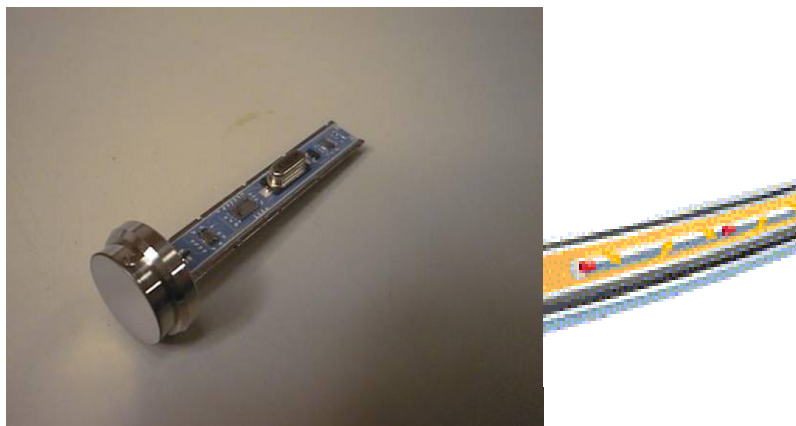
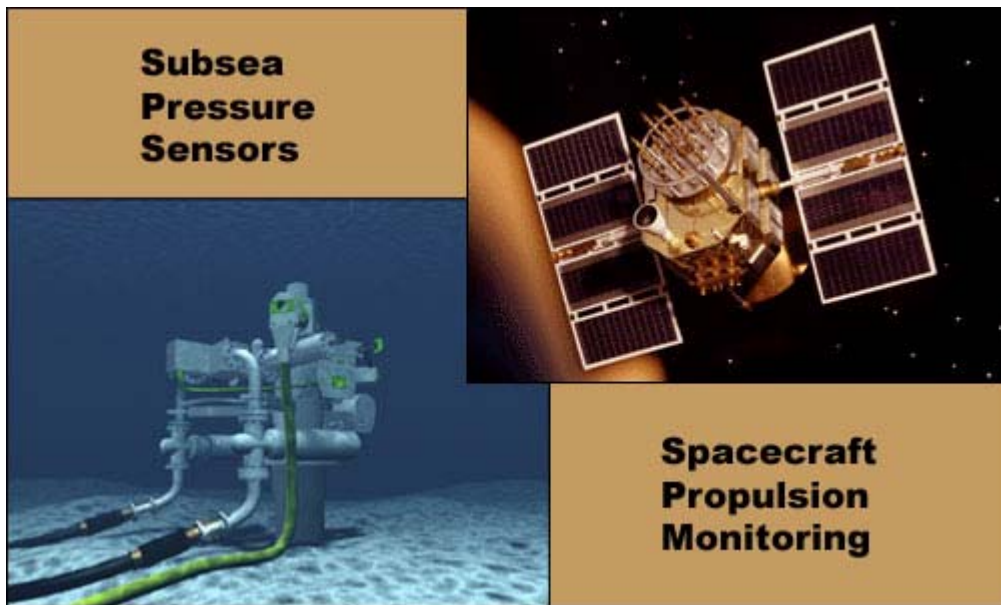
Photoacoustic gas sensor

- Combination of 3 micromachined elements, SINTEF patents
- SensoNor Microsystems Products



Trykksensor for høye trykk (2000 bar)

(Produseres i SINTEFs lab)



P R E S E N S
STATE OF THE ART SENSOR SOLUTIONS

Subsea oil well instrumentation



Flow from different zones of an oil reservoir is controlled by an integrated well control system

Requirements:

1000 bar, 180 C

Monitor

Pressure

Flow

Fluid composition

Temperature

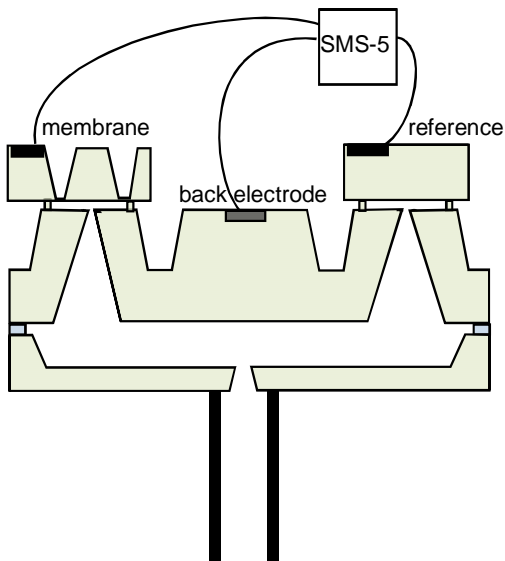
$$C = \frac{A \epsilon \epsilon_0}{x}$$

SINTEF: Interdisciplinarity!

- Design, fabrication and testing of
 - entire “fish”
 - diff. p sensor for flow meas.
- Design/test of HT-ASIC electronics

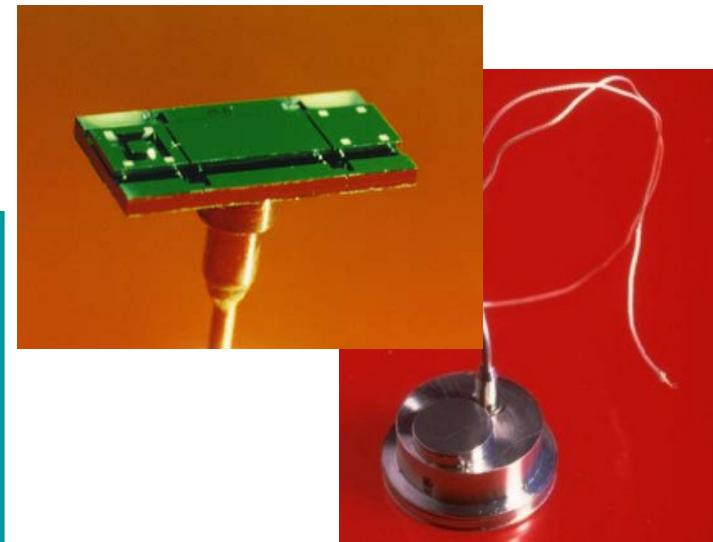
PreSens:

- Absolute p sensor

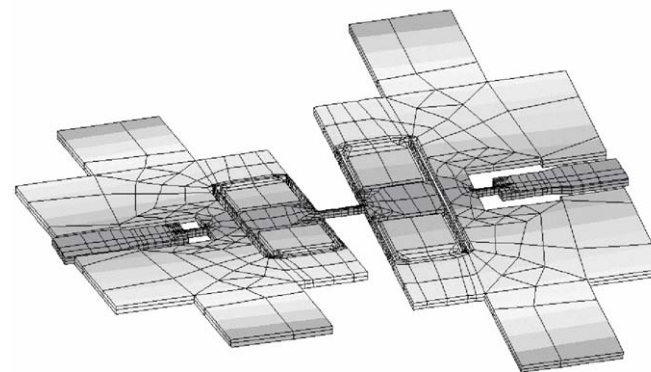
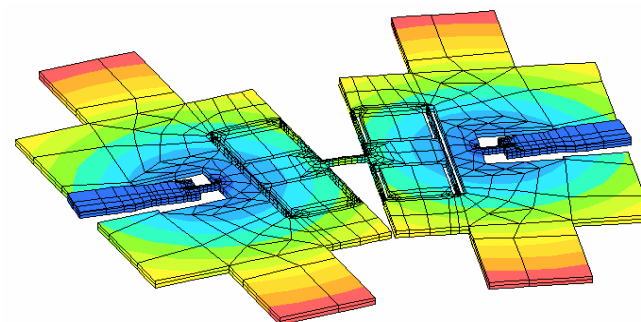
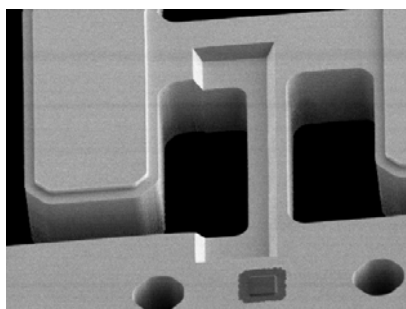
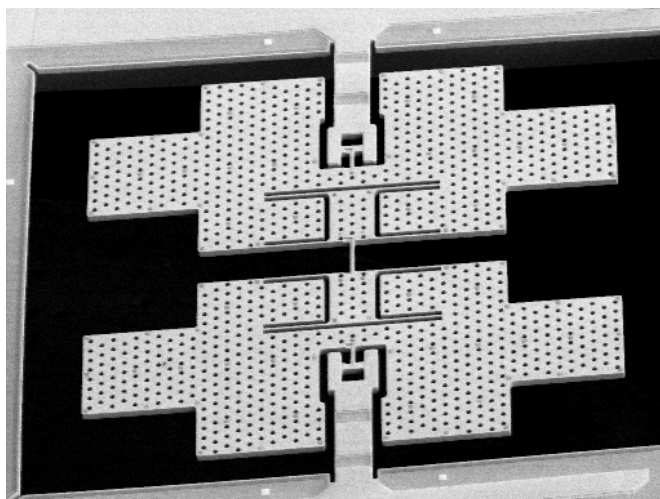
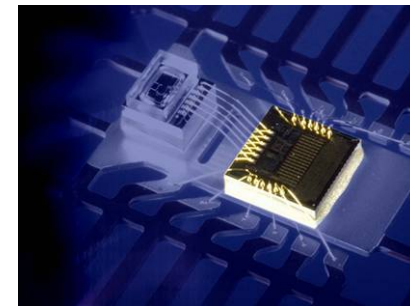


- Capacitive sensing element
- 3-stack fusion bonding (high-T)

- Low zero shift vs. T and p
- Low noise
- High long term stability

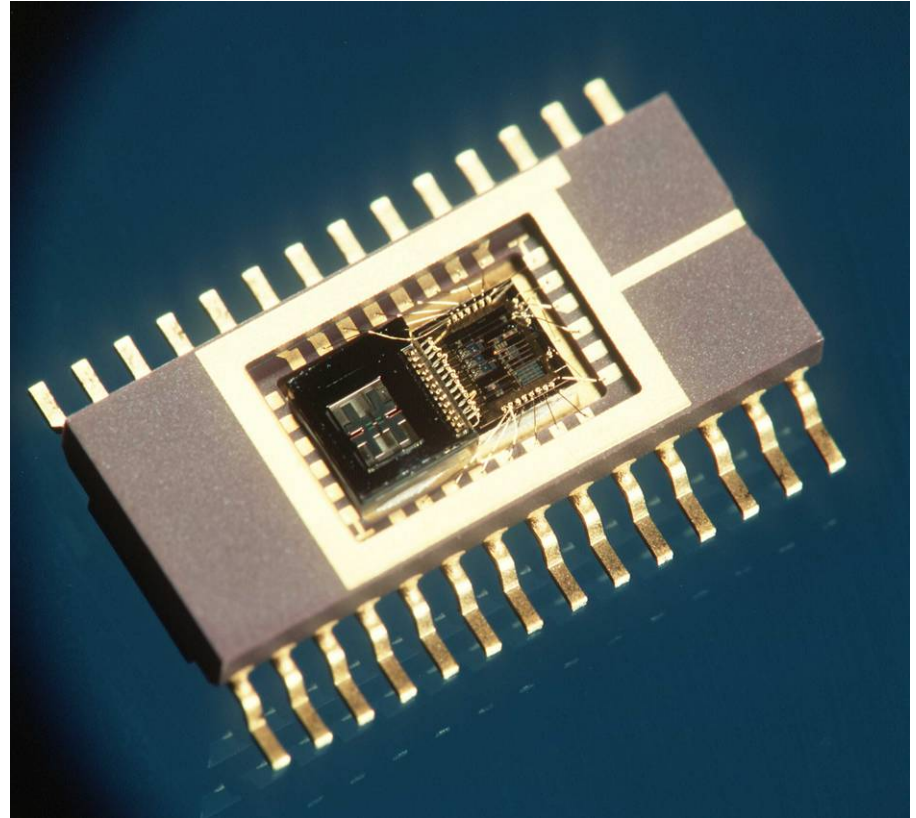


Capacitive roll-over sensor: SensoNor's SAR10



Microelement as part of an electrical circuit

- Read out
- Amplification
- Signal processing
- Feedback



- Lumped element modelling/equivalent circuits

New Micro Flow Rate Sensor for Standardized Industrial Production

3 μm



6 mm



Microsystems and Nanotechnology
SINTEF Information and Communication Technology

The miniature flow rate sensor can be used in diverse applications

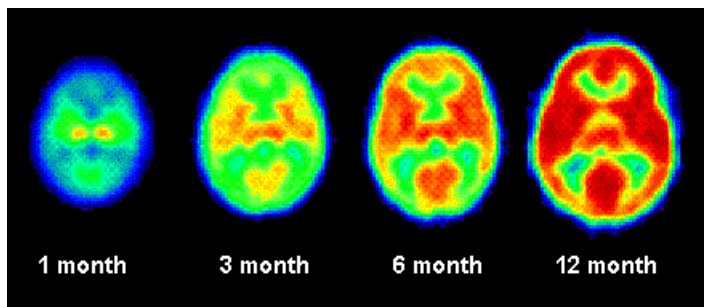
Safety check of implanted medicine pumps



Measuring flow rates of enzymes into bacteria analysis chip

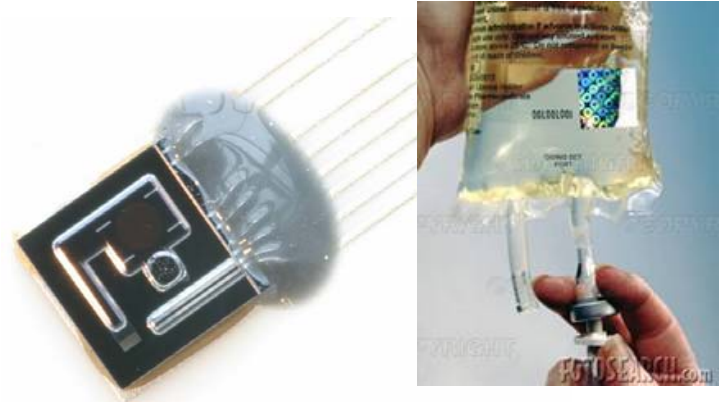


Monitoring the dosing of medicine



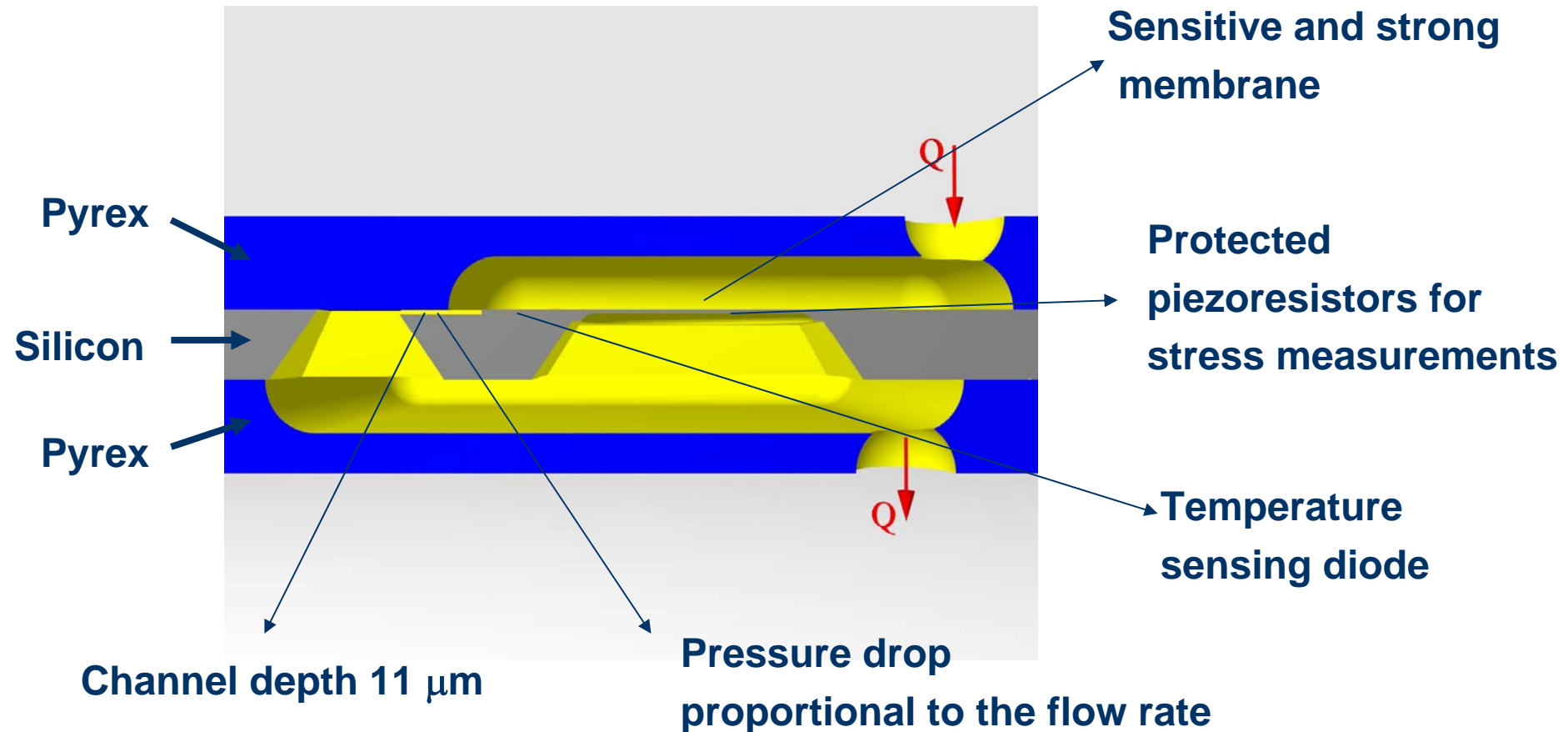
Reagent flow rates in micro reactor for PET radioactive isotopes

The world's leading manufacturing line for tire sensors is used for production of the flow sensor



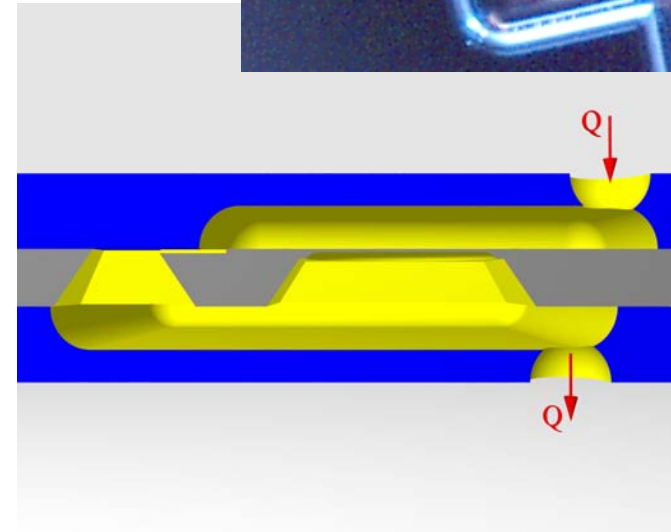
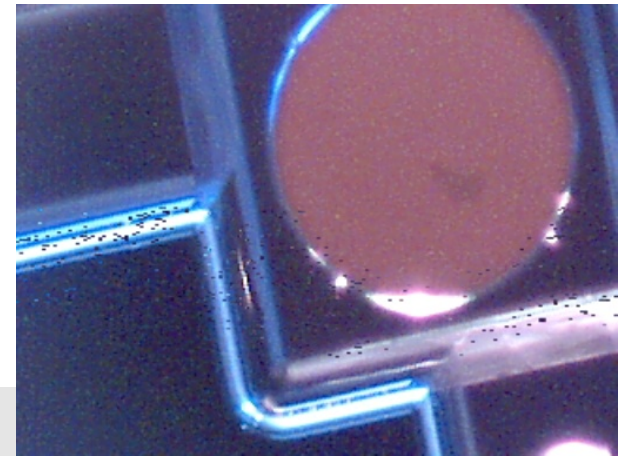
The foundry produces a micro-fluidic element for the first time

The new design suggests a low-noise, mechanically robust flow sensor



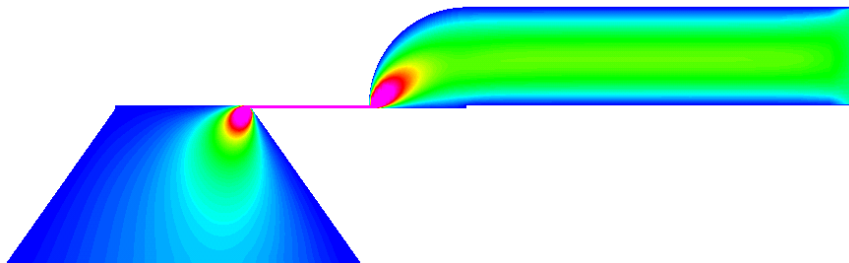
Volum-strømningsmåler

- Applikasjoner: Dosering, tilføring av reagerer, måle flow gjennom analysesystem
- Væskestrøm gjennom brikken
- Glass-silisium-glass brikke
- Laminær strøm, lave Re tall
- Differensiell trykksensor (membran + piezomotstander)
- Trang kanal med trykkfall, Pouseille strøm
- Trykkfall ~ 100 -200 Pa
- Integrert temperaturmåler



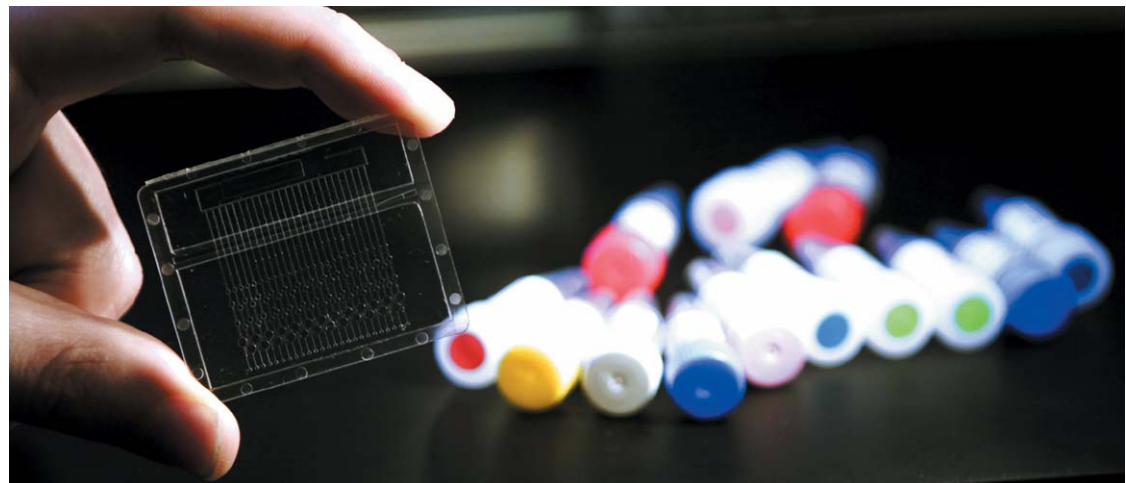
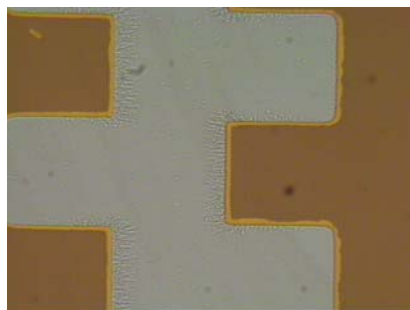
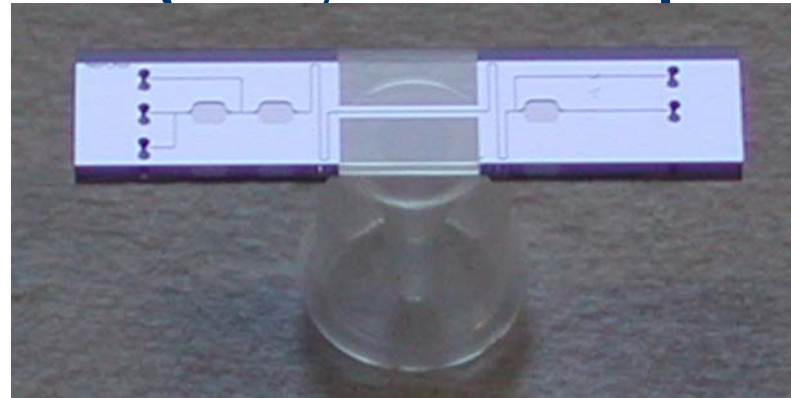
- Kanal: 800x1500x10 μm
- Flow rate 2 $\mu\text{l}/\text{min}$

$$\Delta p = \frac{12 \cdot \eta \cdot l \cdot Q}{w \cdot h^3}$$

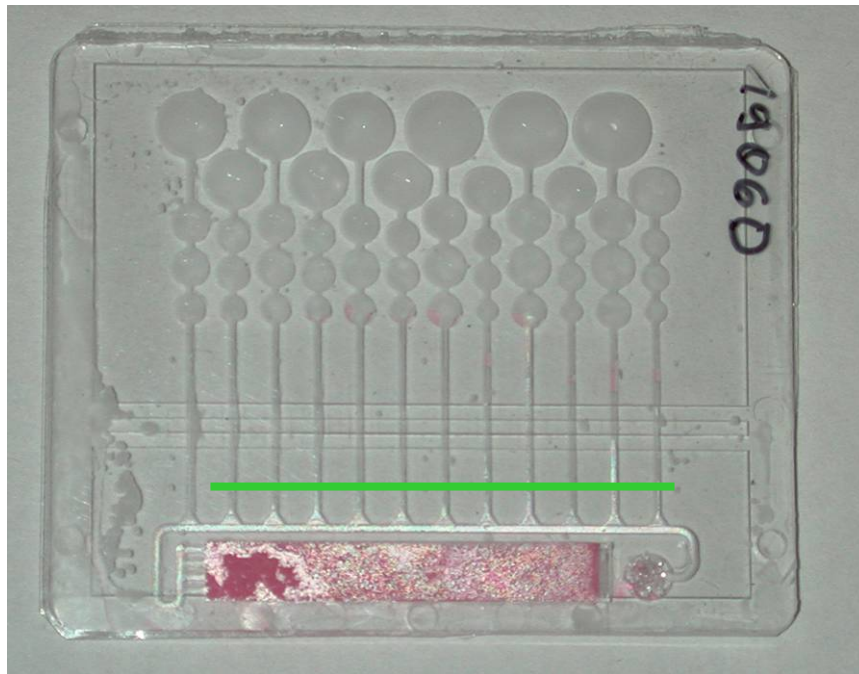


Lab-on-a-chip: NorChip's μ -TAS DNA/RNA/protein analyse

- Oppkonsentrering av kliniske prøver
- Filtrering til rent materiale(RNA, DNA eller proteiner)
- Amplifisering
- Optisk deteksjon



Polymer chip for amplification/optical detection



- **Dimensions: 40 x 50 x 2 mm**
- **12 channels with cross section 400 x 150 μm**

- **Injection moulding of COC polymer**
- **75 μm thick COC membrane chemically bonded with bicyclohexyl**
- **Channels coated with PEG to prevent adsorption of target and enzymes**
- **Produced by IMM, Germany**

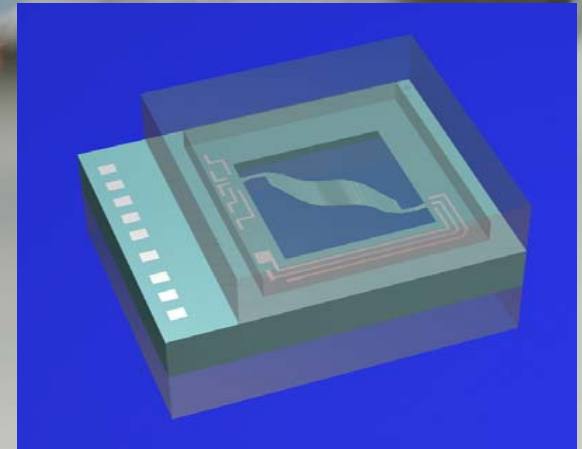
- **50 nl fluid plugs in each channel**
- **Amplification of different parts of RNA in each channel**

Surface modification

- Hydrophilic / hydrophobic surfaces
- Lithographic patterning
- E.g. deposition of self-assembled -monolayers

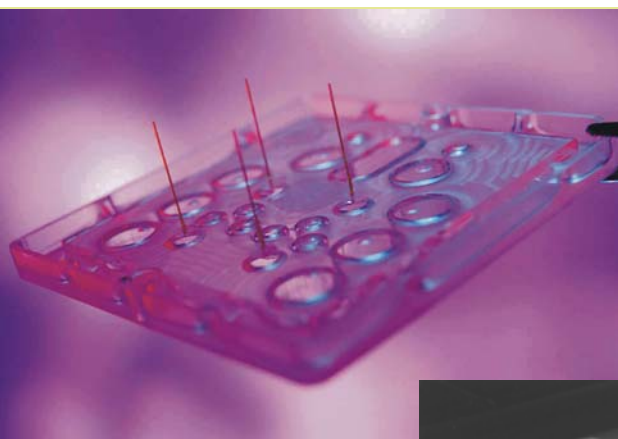


- Chemically active surfaces
 - Biotechnologically active surfaces
-
- Resonance shift due to attached molecules
 - E.g. thermal actuation of resonance vibrations



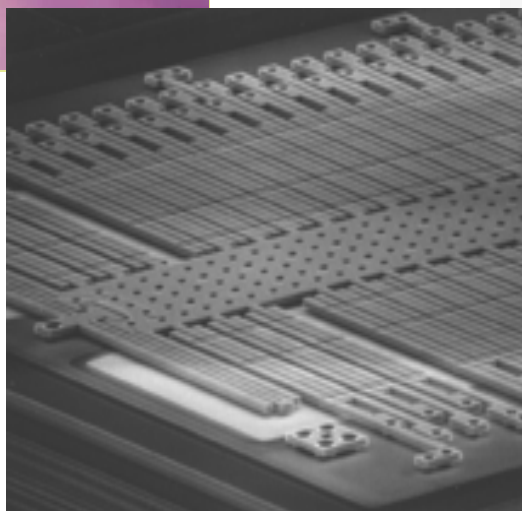
Course contents, 4 main “cases”:

- 1) Micro fabrication
- 2) Design of lithographic masks
- 3) Physics governing behaviour of microsystems
- 4) Modelling of behaviour of microsystems



PCR analysis –
microfluidics

Accelerometer –
Inertial forces



Projector –
optics/mechanics/
electrostatic

Pressure sensor –
elasticity/
electronics



■ Oppgave:

Finn mikro-foundrier på web

Søk på f.eks.

microtechnology

foundry

mpw

mumps

multi user

micromachining